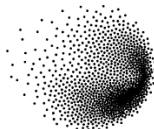




UNIVERSITÉ
DE GENÈVE

FACULTÉ DES SCIENCES



PSI



Swiss National
Science Foundation

Nb_3Sn advanced pinning technology for FCC-hh and other high field projects

***Gianmarco BOVONE, Francesco LONARDO, Florin BUTA,
and Carmine SENATORE***

Department of Quantum Matter Physics, University of Geneva, Switzerland
Department of Nuclear and Particle Physics, University of Geneva, Switzerland



Swiss Accelerator
Research and
Technology

Outline

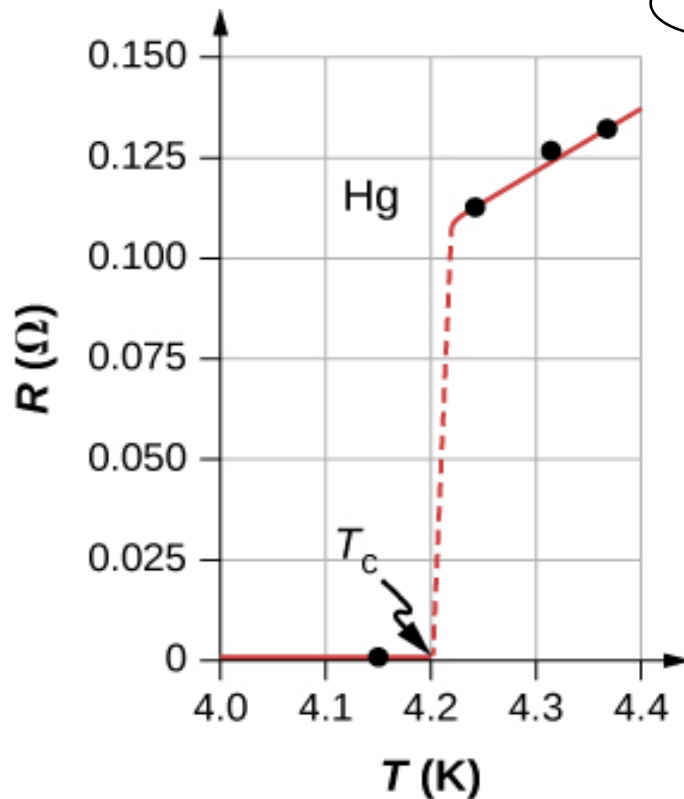
- *A brief history of Nb₃Sn*
- *From bronze to internal Sn wires:
the multifilamentary wires age*
- *J_c and B_{c2} are essential, yet not sufficient for applications*
- *FCC-hh and the new challenges for Nb₃Sn*

Outline

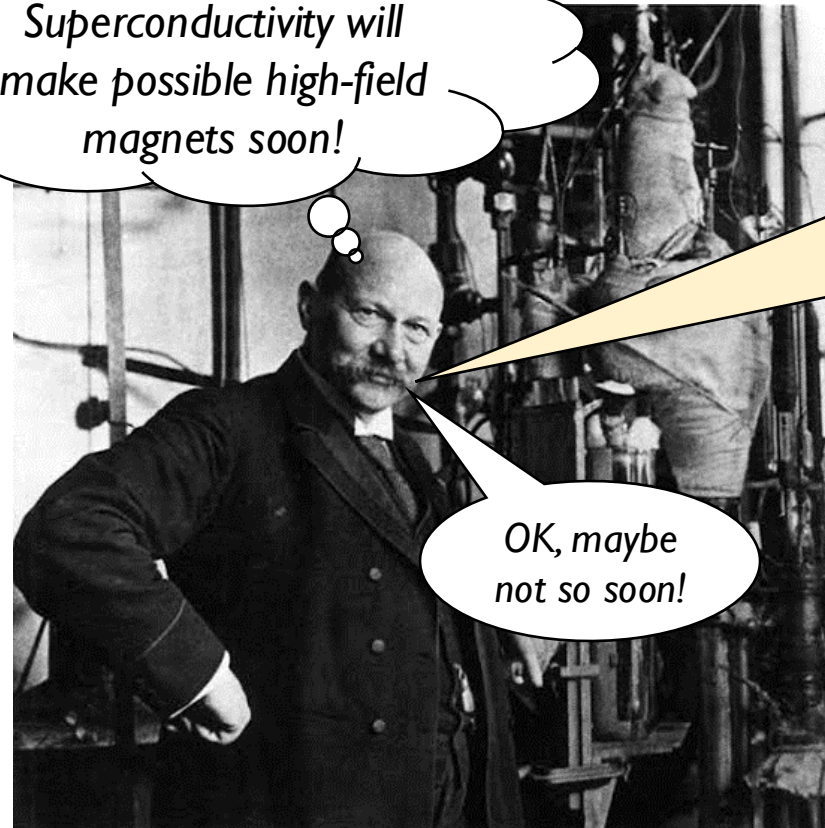
- ***A brief history of Nb₃Sn***
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Discovery of superconductivity

Discovery of superconductivity in 1911



Superconductivity will make possible high-field magnets soon!



OK, maybe not so soon!

Heike Kamerlingh Onnes

The field
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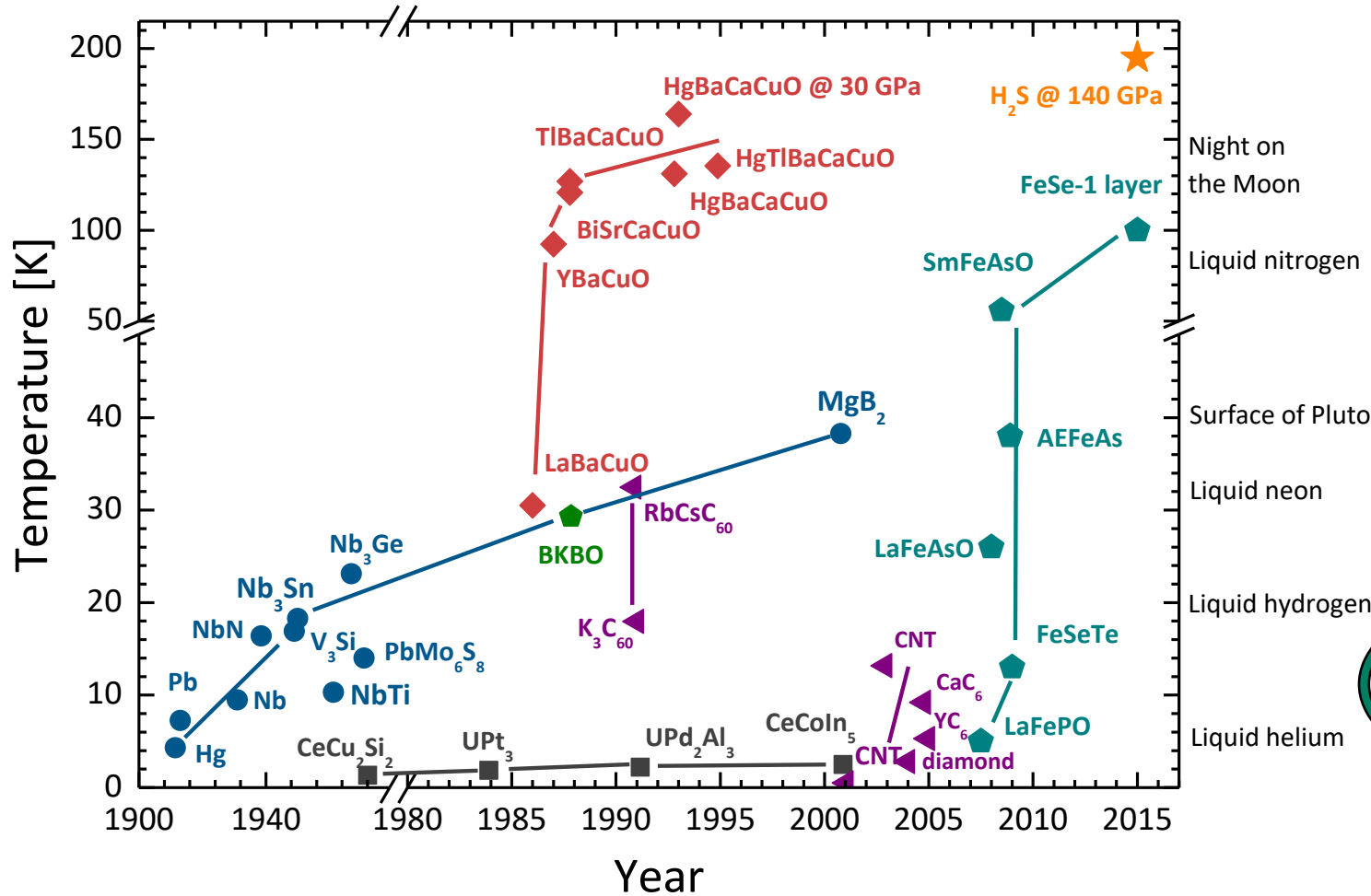
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TABLE I. Critical constants for superconducting mercury.

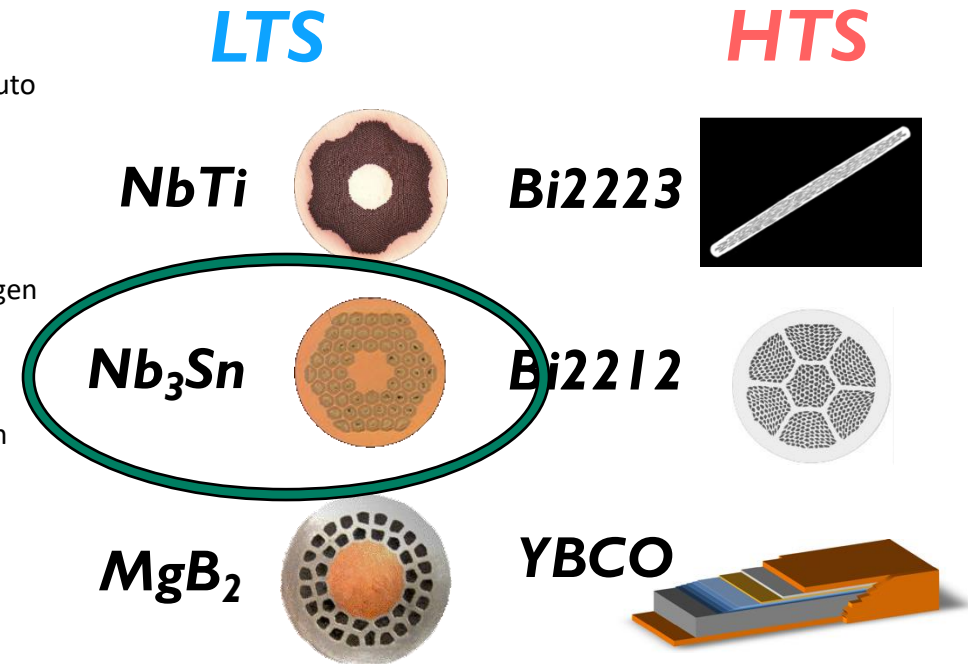
Sample	T_c (°K)	H_0 (gauss)	γ millijoules/mole°K ²
Hg-1	4.1535 ± 0.0005	$415.4 \pm 0.5, -1.5$	$1.103 \pm 0.01, -0.04$
Hg-3	4.153 ± 0.001	415.1 ± 0.5	1.088 ± 0.01
Hg-4	4.1531 ± 0.0005	$414.9 \pm 0.5, -1.5$	$1.108 \pm 0.01, -0.04$
Hg-5	4.1532 ± 0.0005	414.4 ± 0.4	1.079 ± 0.01

M. Wilson *IEEETAS* (2012) 22 3800212
D.K. Finnemore et al. *Physical Review* (1960) 1181

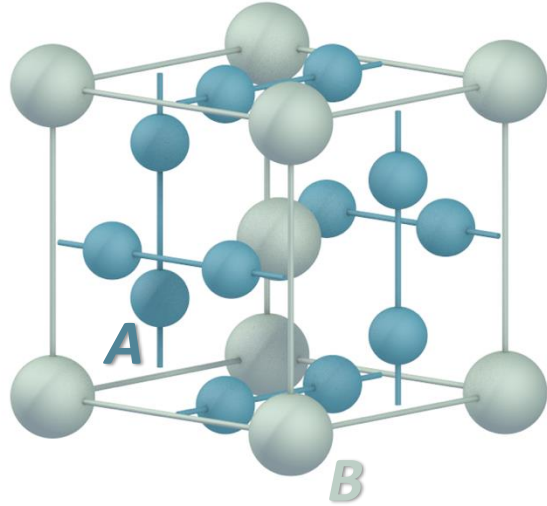
Superconductors are not created equal



<input type="checkbox"/> Have a T_c ?	>10000
<input type="checkbox"/> $T_c > 4.2$ K, $B_{c2} > 10$ T?	100
<input type="checkbox"/> High J_c ?	10



Al5 compounds

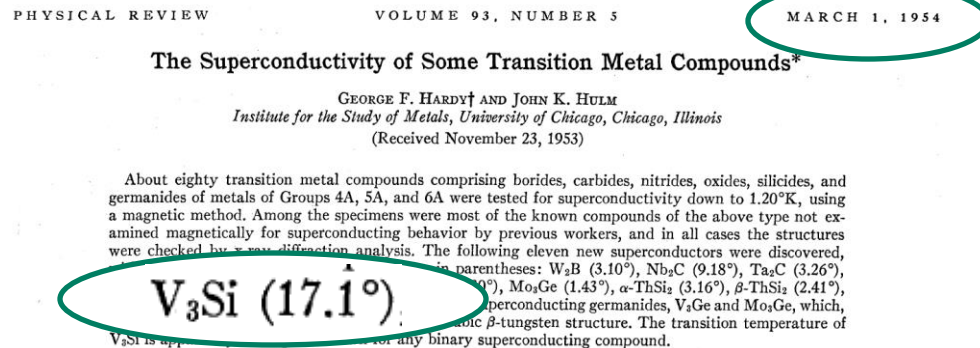


***The name originates from
Strukturbericht notation with
chemical formula A_3B***

**More than 50 superconductors,
10 of them with $T_c \geq 15$ K**

V_3Ga , Nb_3Sn and Nb_3Al can be produced as practical conductors

V_3Si is the earliest example, $T_c = 17.1$ K (Hardy, 1954)



Nb₃Ge held the record for the highest T_c (23.2 K) until 1986

	Ti	Zr	V	Nb	Ta	Cr	Mo
Al			11.8 K	18.8 K			0.6 K
Ga			16.8 K	20.3 K			0.8 K
In			13.9 K	9.2 K			
Tl				9.0 K			
Si			17.1 K	19.0 K			1.7 K
Ge			11.2 K	23.2 K	8.0 K	1.2 K	1.8 K
Sn	5.8 K	0.9 K	7.0 K	18.0 K	8.4 K		
Pb		0.8 K		8.0 K	17.0 K		
As			0.2 K				
Sb	5.8 K		0.8 K	2.2 K			
Bi		3.4 K		4.5 K			
Tc							15.0 K
Re							15.0 K
Ru						3.4 K	10.6 K
Os			5.7 K	1.1 K		4.7 K	12.7 K
Rh			1.0 K	2.6 K	10.0 K	0.3 K	
Ir	5.4 K		1.7 K	3.2 K	6.6 K	0.8 K	9.6 K
Pd			0.08 K				
Pt	0.5 K		3.7 K	10.9 K	0.4 K		8.8 K
Au		0.9 K	3.2 K	11.5 K	16.0 K		

Nb_3Sn : an old material still to be unraveled

Nb_3Sn came 6 month after V_3Si , $T_c = 18$ K (Matthias, 1954)

PHYSICAL REVIEW

VOLUME 95, NUMBER 6

SEPTEMBER 15, 1954

Superconductivity of Nb_3Sn

B. T. MATTHIAS, T. H. GEBALLE, S. GELLER, AND E. CORENZWIT
Bell Telephone Laboratories, Murray Hill, New Jersey
(Received June 10, 1954)

Intermetallic compounds of niobium and tantalum with tin have been found. The superconducting transition temperature of Nb_3Sn at 18°K is the highest one known.

Nb_3Sn at 18°K

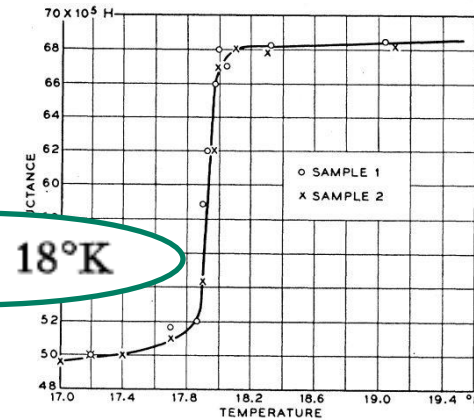


FIG. 1. Variation of susceptibility with temperature of Nb_3Sn .

VOLUME 6, NUMBER 3

PHYSICAL REVIEW LETTERS

FEBRUARY 1, 1961

SUPERCONDUCTIVITY IN Nb_3Sn AT HIGH CURRENT DENSITY IN A MAGNETIC FIELD OF 88 kgauss

J. E. KUNZLER, E. BUEHLER, F. S. L. HSU, AND J. H. WERNICK
Bell Telephone Laboratories, Murray Hill, New Jersey
(Received January 9, 1961)

... and Nb_3Sn exhibited very **high in-field** J_c (Kunzler, 1961)

exceeding 100 000 amperes/cm² in magnetic fields as large as 88 kgauss.

B.T. Matthias et al. *Physical Review* (1954) 95.6 1435

J.E. Kunzel et al. *Physical Review Letters* (1961) 6.3

Adapted from R. Flükiger et al. *Cryogenics* (2008) 48 293

Nb_3Sn : the first high field Nb_3Sn magnet

First Nb_3Sn magnet
to generate 10 T
(GE, 1963)

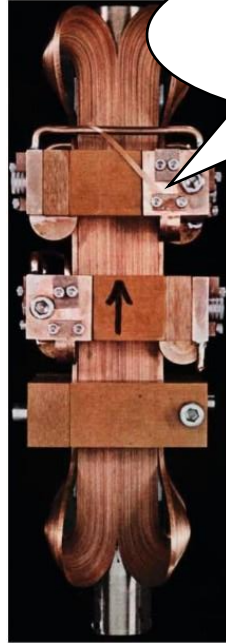


Magnet, fabricated and tested by: L. Martin, C. Bruch, M. Benz and C. Rosner (left to right)

Worked only ONCE!

- B.T. Matthias et al. *Physical Review* (1954) 95.6 1435
L. Rossi and A.V. Zlobin *Nb₃Sn Accelerator Magnets* (2019): 53
M. G. Benz *IEEE Trans. Mag.* (1966) 2 760
H. Rosner et al. *IEEE-CSC ESAS Eur. Supercond. News Forum*. No. 9. (2012)
E. Barzi and A.V. Zlobin *Nb₃Sn Wires and Cables for High-Field Accelerator Magnets* (2019)

First Nb_3Sn
quadrupole with 30
mm bore (BNL, 1968)

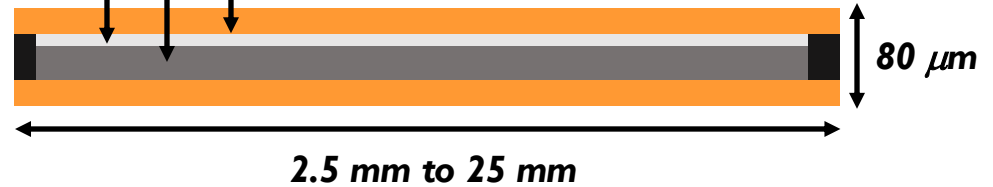


Nb_3Sn coated conductors (!!)

Superconducting film - Nb_3Sn or V_3Ga , $\sim 10 \mu m$

Base metal - Nb or V

Cu stabilizer, laminated or electroplated



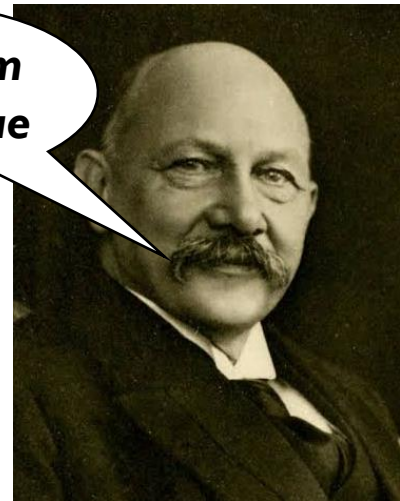
Liquid Diffusion Process:

Nb ribbon coated with **Sn** and heat
treated at 900-1200°C for several hours

Developed at General Electric and
used in 15 T-class R&W magnets



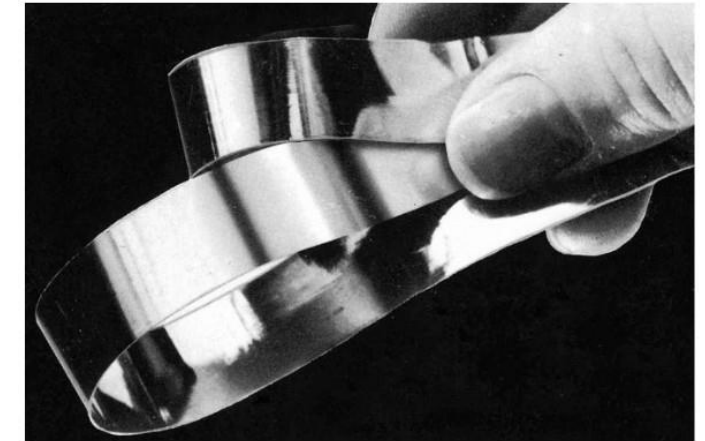
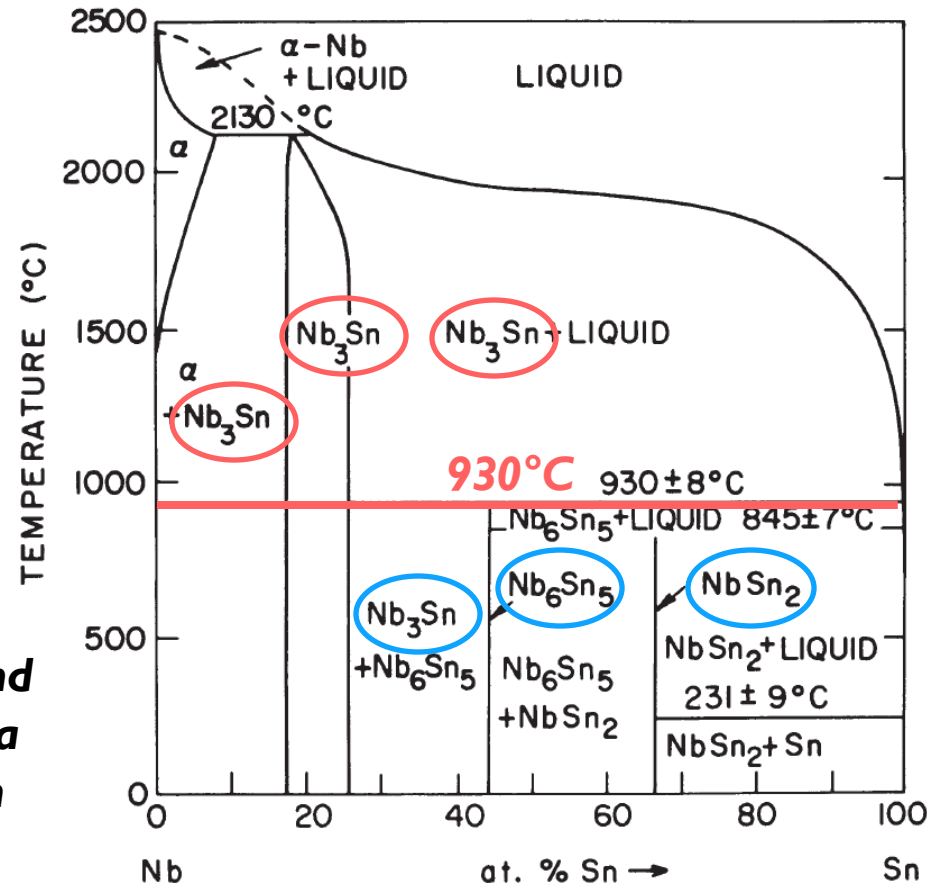
My dream
comes true



Nb_3Sn : a complicated family

Nb_3Sn is the only stable compound **above 930 °C**

Below 930 °C also Nb_6Sn_5 and $NbSn_2$ are stable, and have a better kinetics of formation



The reaction of Nb and Sn to form Nb_3Sn needs to be performed at $T > 930^\circ\text{C}$

D. P. Charlesworth et al., J. of Mat. Sci. (1970) 5 580

Not only Nb and Sn

Tachikawa and his co-workers at NRIM, Tokyo, discovered that Cu was acting as a catalyst for the formation of the A15 phase, making possible the synthesis of V_3Ga at lower temperatures

If it works for V_3Ga , why not trying in Nb_3Sn ?



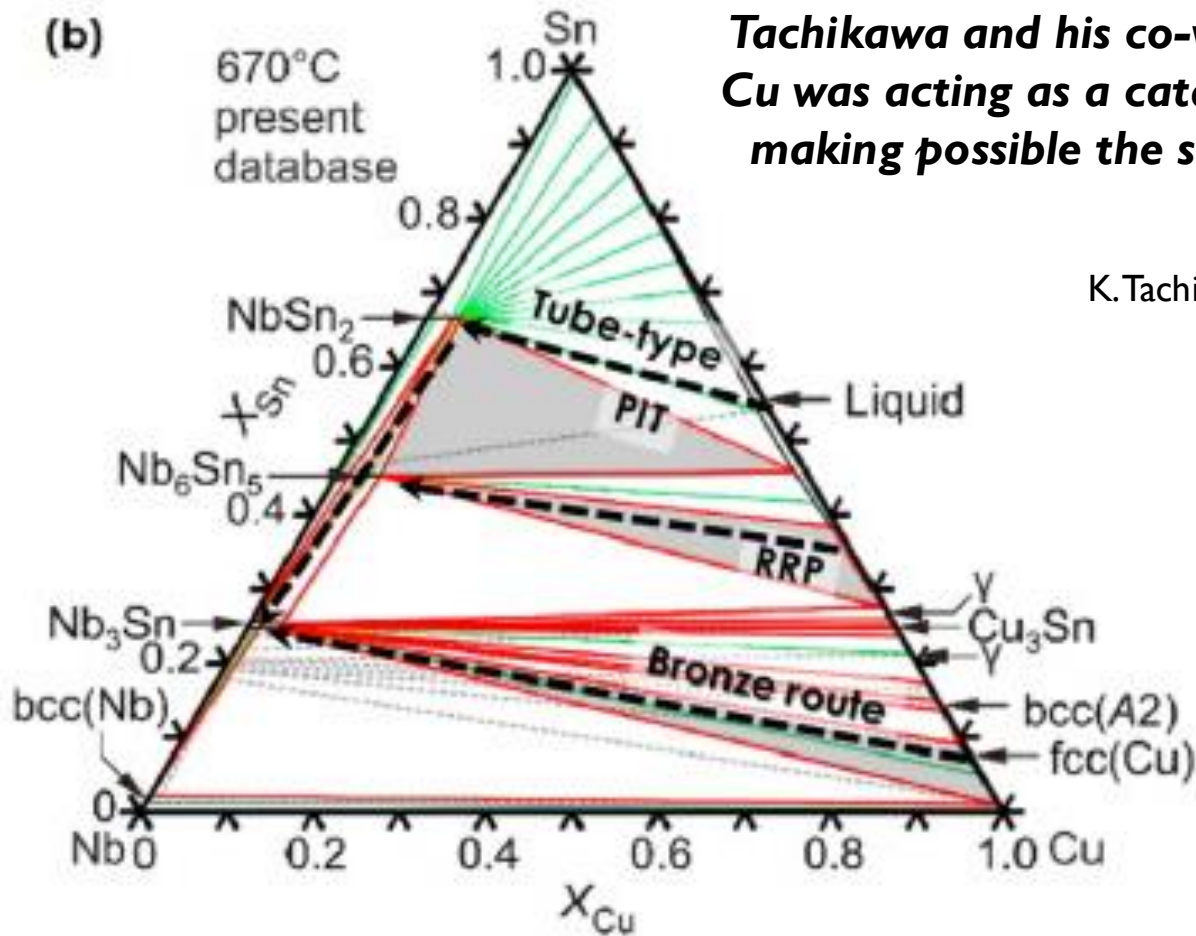
Prof. Kyoji
TACHIKAWA

K. Tachikawa, Y. Tanaka and S. Fukuda, Japan Pat.
0670619 (Filed June 25, 1966)

K. Tachikawa and Y. Tanaka, Jap. J. Applied
Physics 6 (1967) 782

**Researcher in UK and US came at the
same conclusion almost at the same time**

**The addition of Cu lowers
the formation temperature
of Nb_3Sn down to $\sim 650^\circ C$**

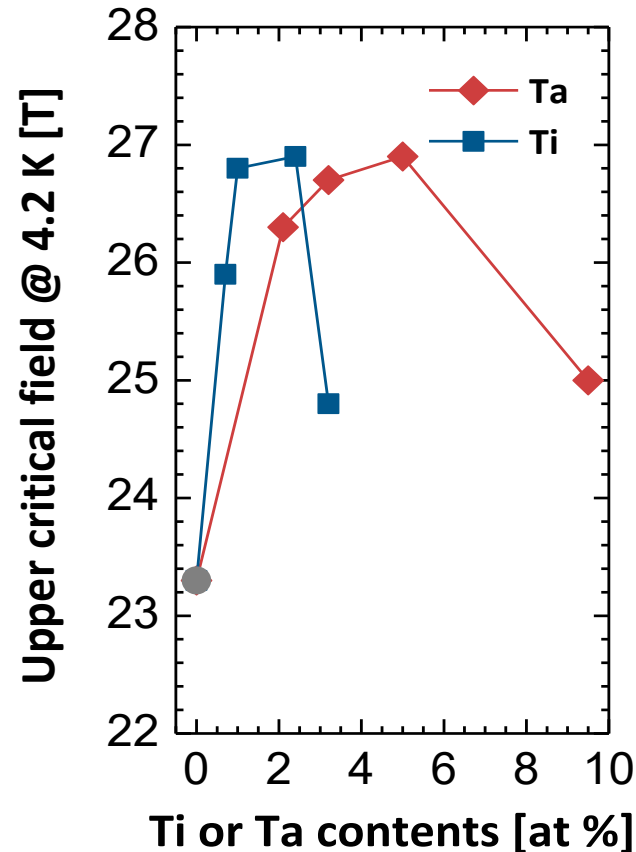


Not only Nb and Sn

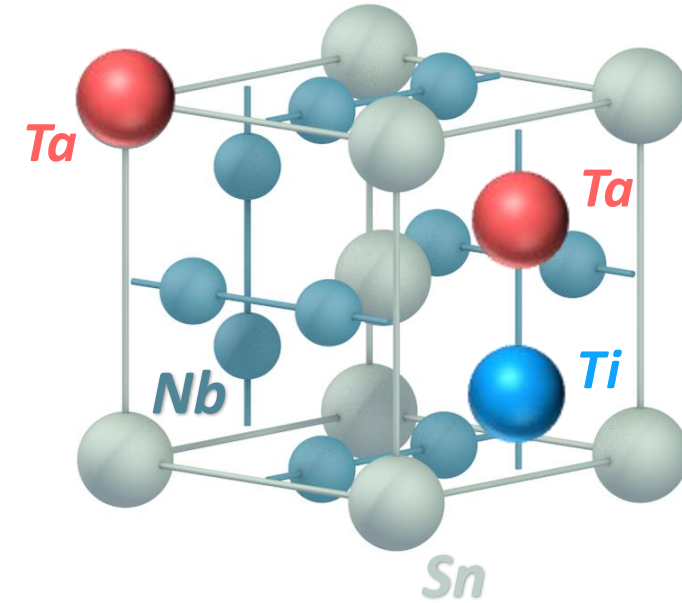
Ta and **Ti** enhance B_{c2} and now are used in all industrial wires

$$B_{c2} \propto \gamma \rho_n T_c$$

B_{c2} is proportional to defects



Adapted from M. Suenaga et al.,
JAP **59** (1986) 840



From EXAFS investigations

- **Ta** substitutes both **Nb** and **Sn**
- **Ti** substitutes **Nb**

S. M. Heald et al. Sci. Rep. (2018) 8 4798

Outline

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the multifilamentary wires age**
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Why multifilamentary wires are important

Nb₃Sn tape, Cu plated

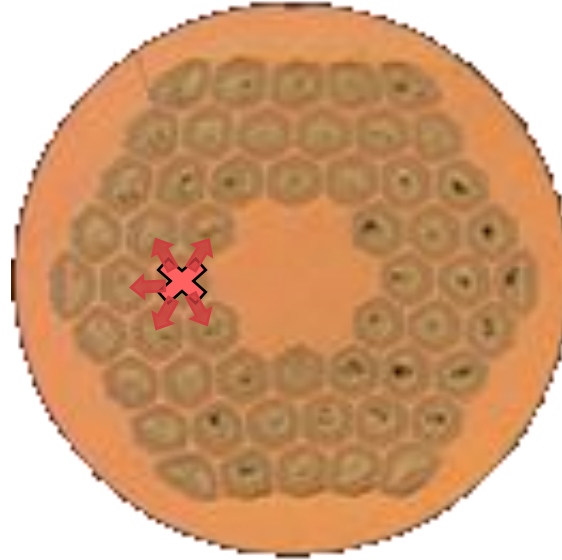
Sn deficiency,
defects, etc.

Cracks

What happens?

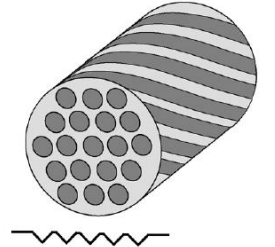
Quench!

The sudden and undesirable transition from a superconducting state to a normal state. When a quench occurs, the stored energy in the superconductor is rapidly converted into heat



In a multifilamentary wire, in case of cracks or defects, J_c can be shared by adjacent filaments!

Filaments can be twisted to avoid current coupling in case the matrix resistivity is low

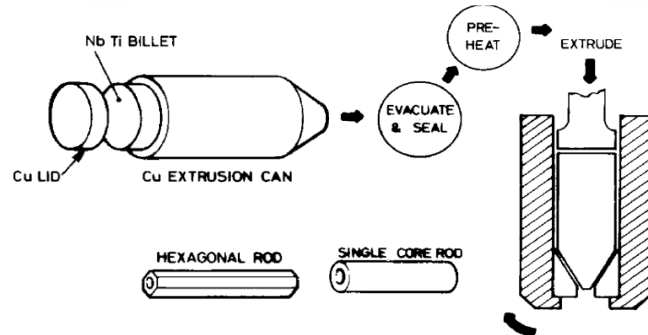


- Minimize AC losses
- Reduce coil magnetisation
- Improve electromechanical stability

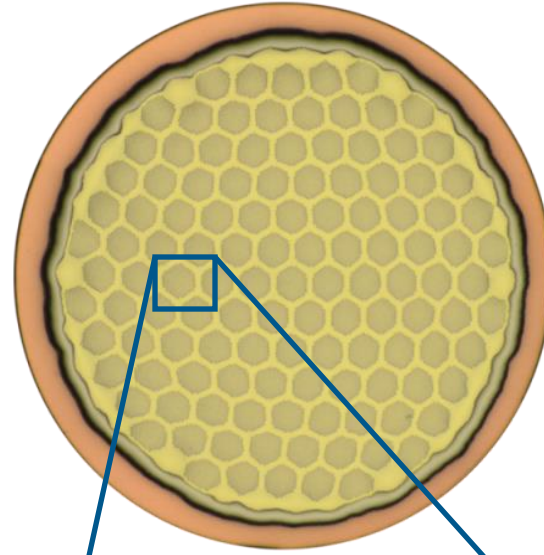
Multifilamentary wire are more “stable”!

The bronze route and multifilamentary wires

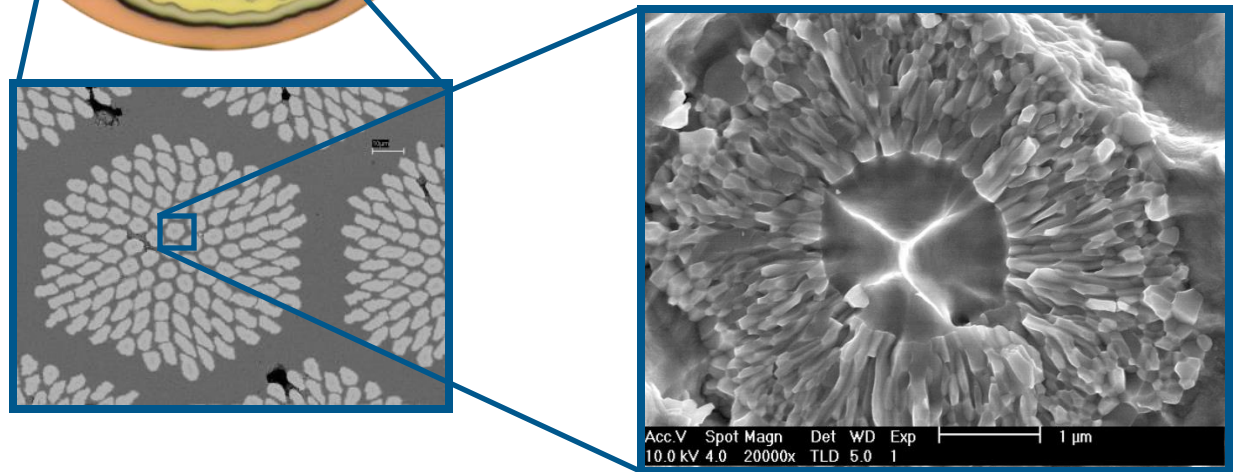
Bronze ingots for Nb_3Sn wires
(Courtesy of Osaka Alloying Works Co)



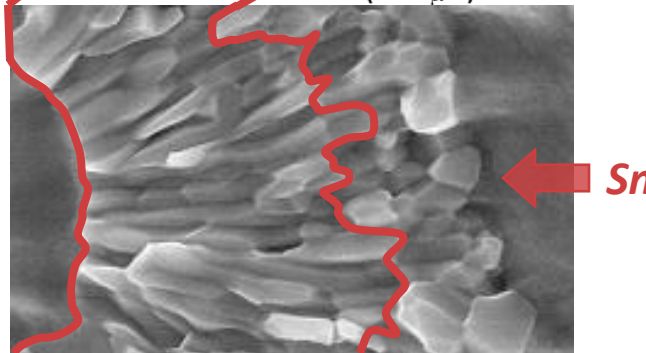
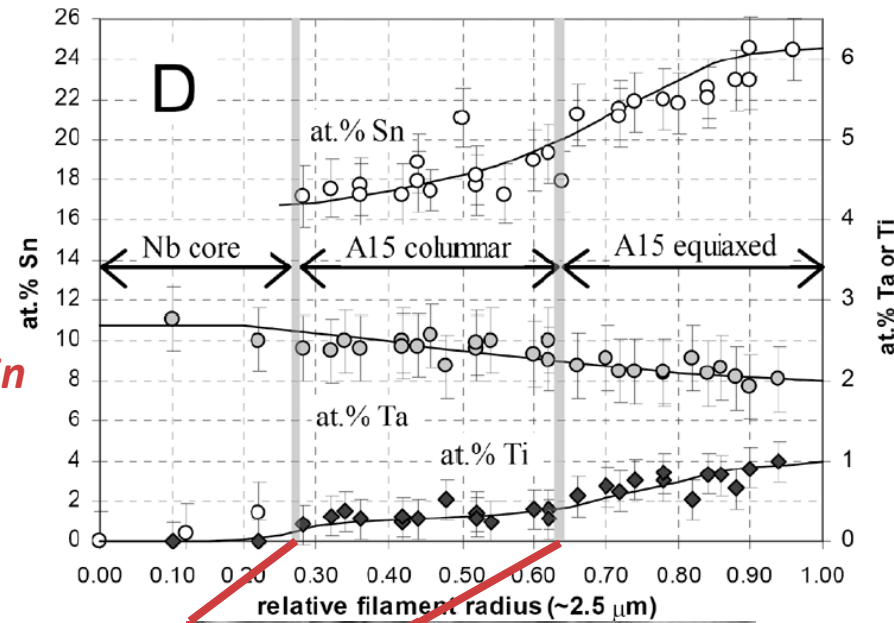
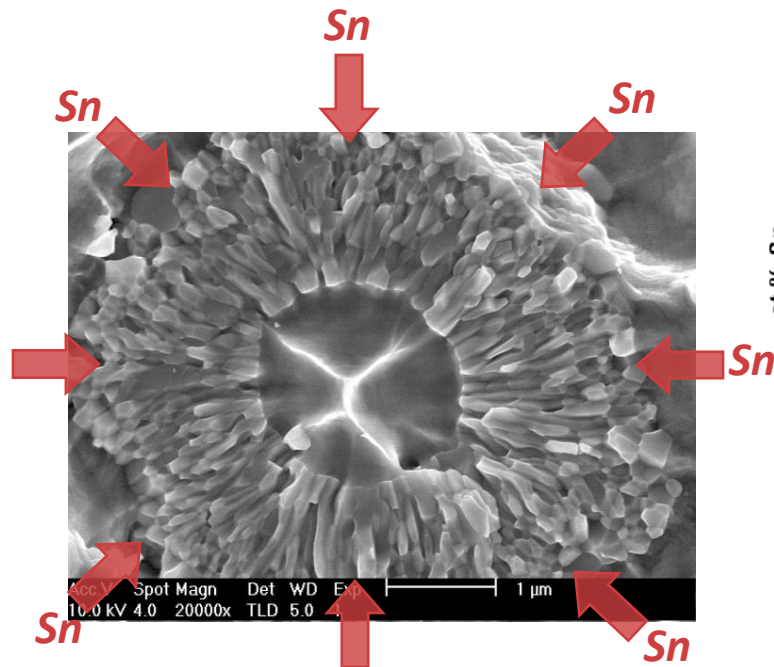
K. Tachikawa and P. Lee, Nb_3Sn and related A15s, Chapter 11
E.W. Howlett, Great Britain Pat. 52, 623/69 (Filed Oct. 27, 1969)
A. R. Kaufman and J. J. Pickett, Bull. Am. Phys. Soc. (1970) 15 833



Nb filaments in a bronze matrix (mix of Cu and Sn).
The Sn from the bronze diffuse in Nb to form Nb_3Sn at low temperature (650°C)



Different grains, different properties



Sn content changes drastically along the Nb₃Sn layer

Equiaxed grains: 21-25 at.% Sn

Columnar grains: 18-21 at.%

Also grain size is different

Equiaxed grain size ~150 nm

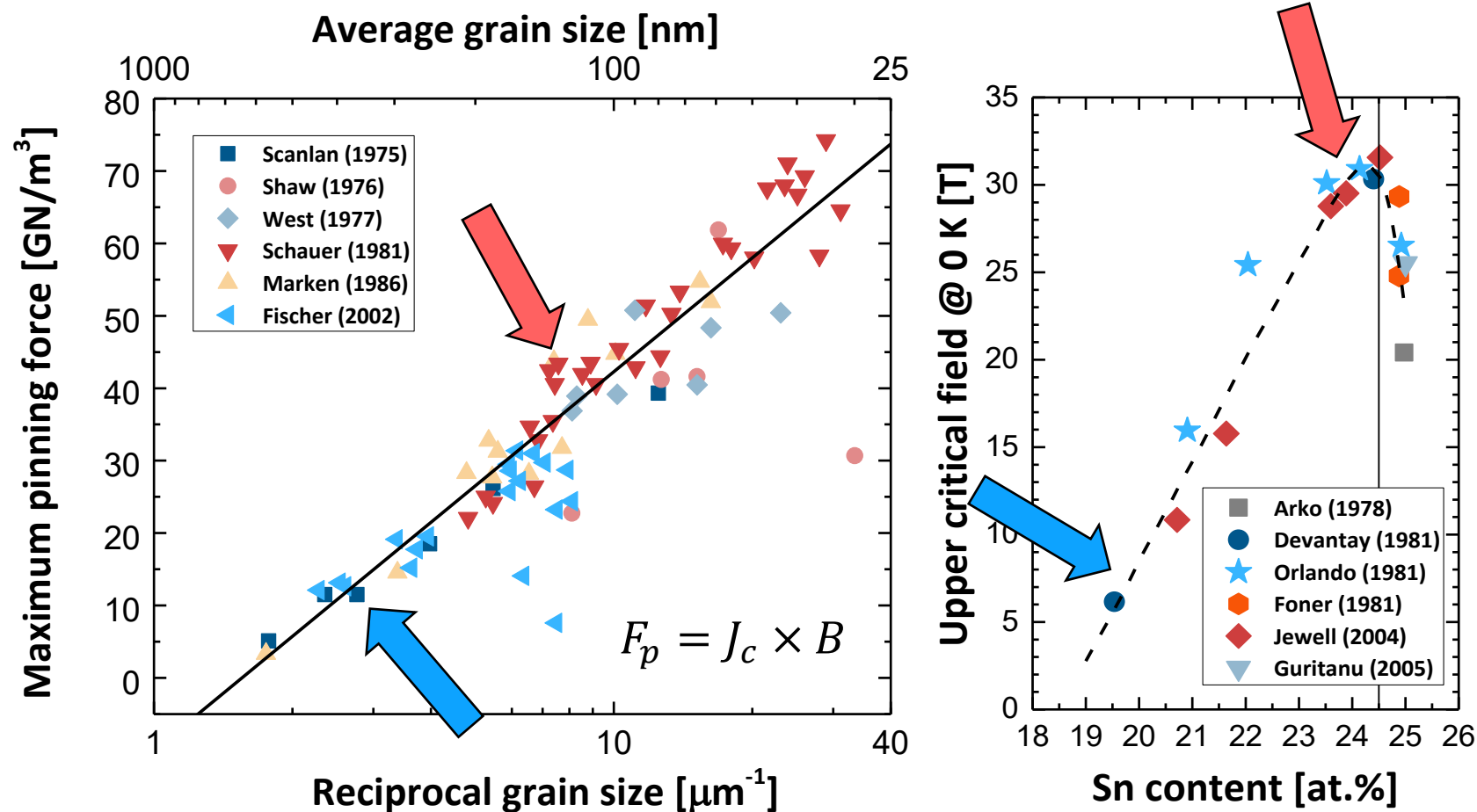
Columnar grain size up to 400 nm

Effect due to low Sn content in bronze

Does these differences affect superconducting properties?

V. Abächerli et al. IEEE TAS (2005) 15 3482

Different grains, different properties

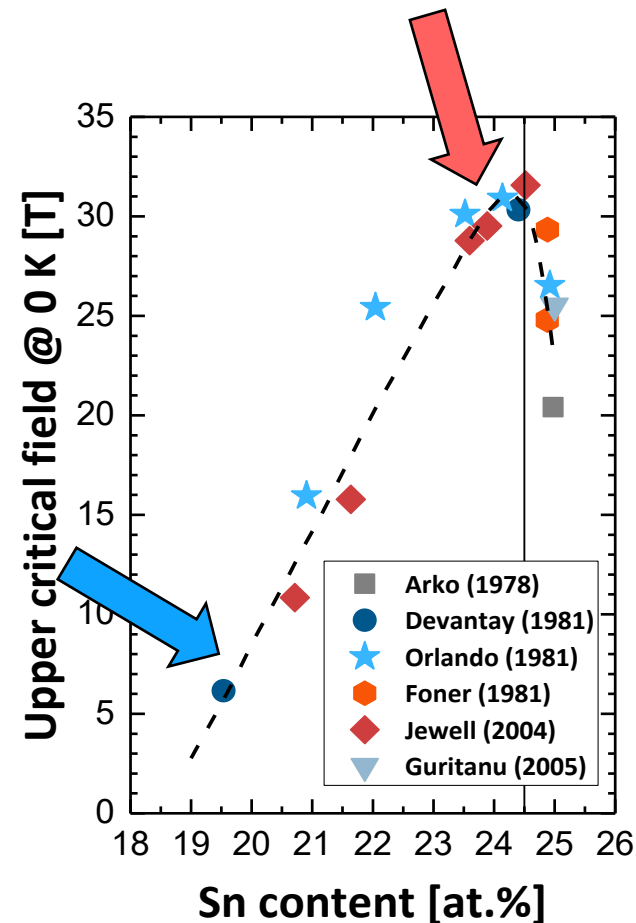
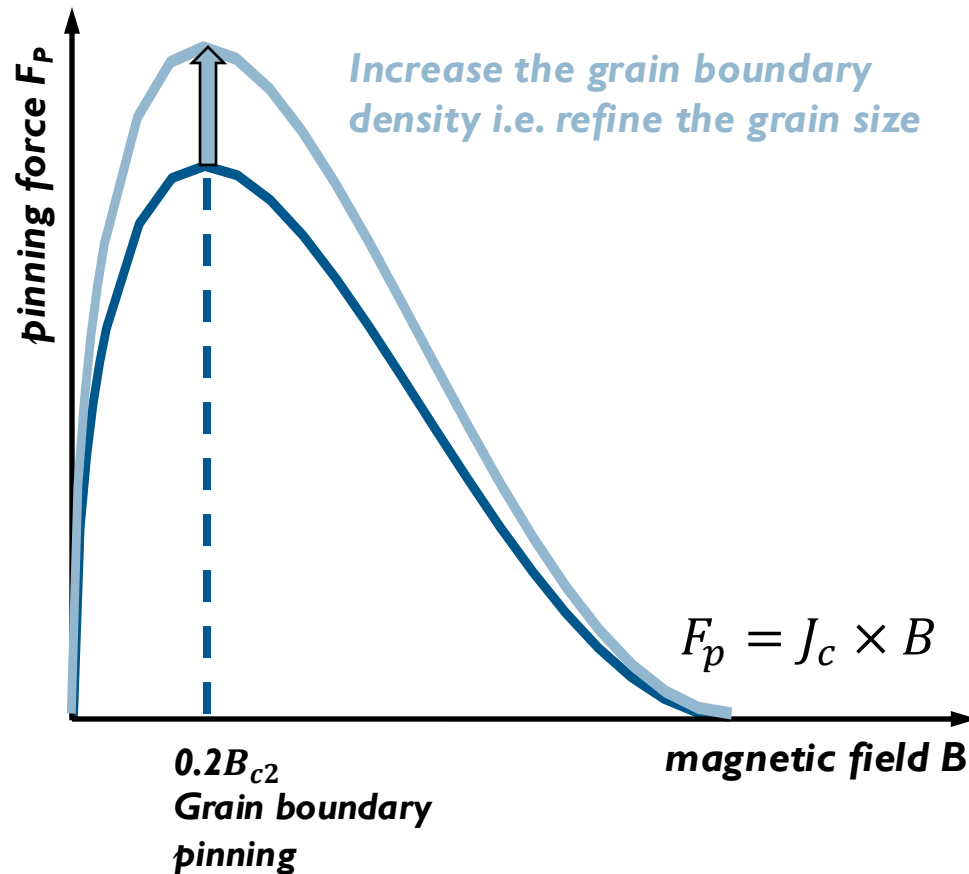


Columnar grains (18-21 at.% Sn, 400 nm) have lower B_{c2} and contribute less to J_c than equiaxed grains (21-25 at.% Sn, 150 nm)

Why J_c increase at finer grain size?

Adapted from A. Godeke, SUST (2006)19 R68

Different grains, different properties



Columnar grains (18-21 at.% Sn, 400 nm) have lower B_{c2} and contribute less to J_c than equiaxed grains (21-25 at.% Sn, 150 nm)

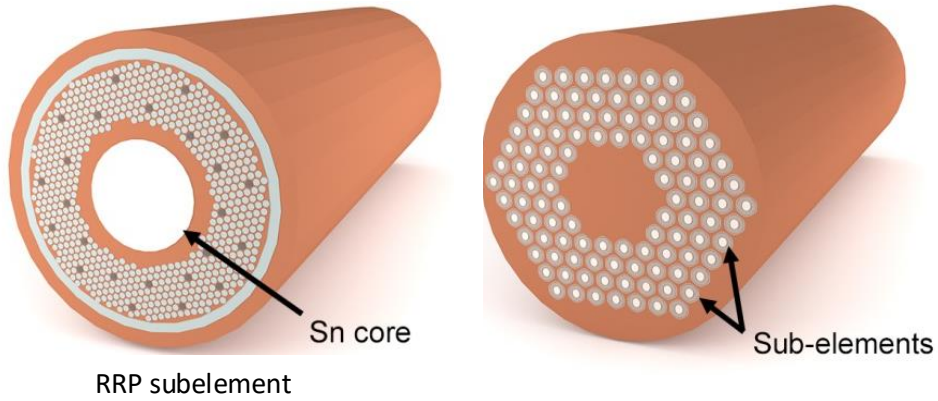
Why J_c increase at finer grain size?

The flux line lattice is pinned by pinning centers (e.g., grain boundaries). The more grain boundaries, the higher the F_p

How to have more Sn and good deformability?

Adapted from A. Godeke, SUST (2006) 19 R68

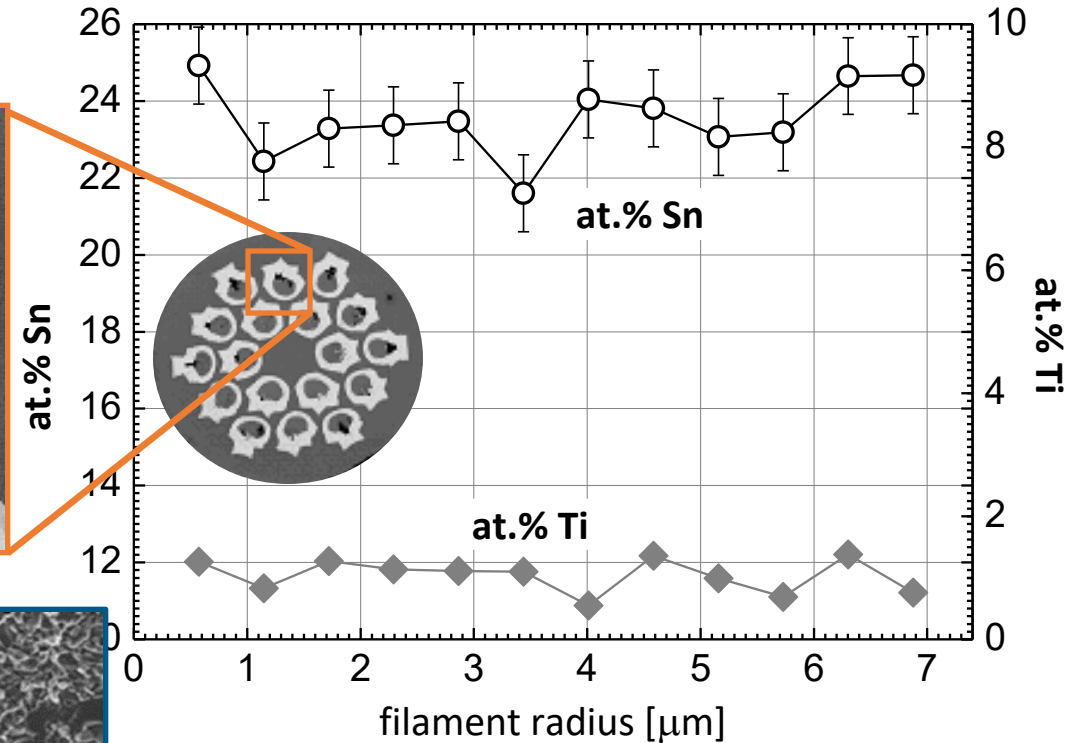
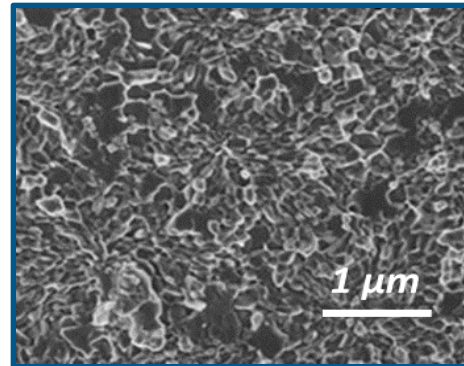
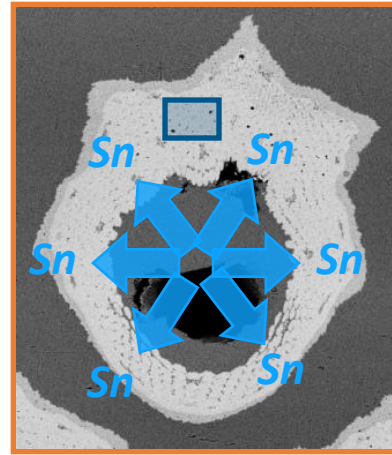
More Sn for the internal Sn



Bronze is substituted by a Sn rod in a Cu matrix

Sn and Cu are deformed easily Sn content can be maximized

Internal Sn includes different type of wires. The most notable are the Rod Restack Process (RRP) wires

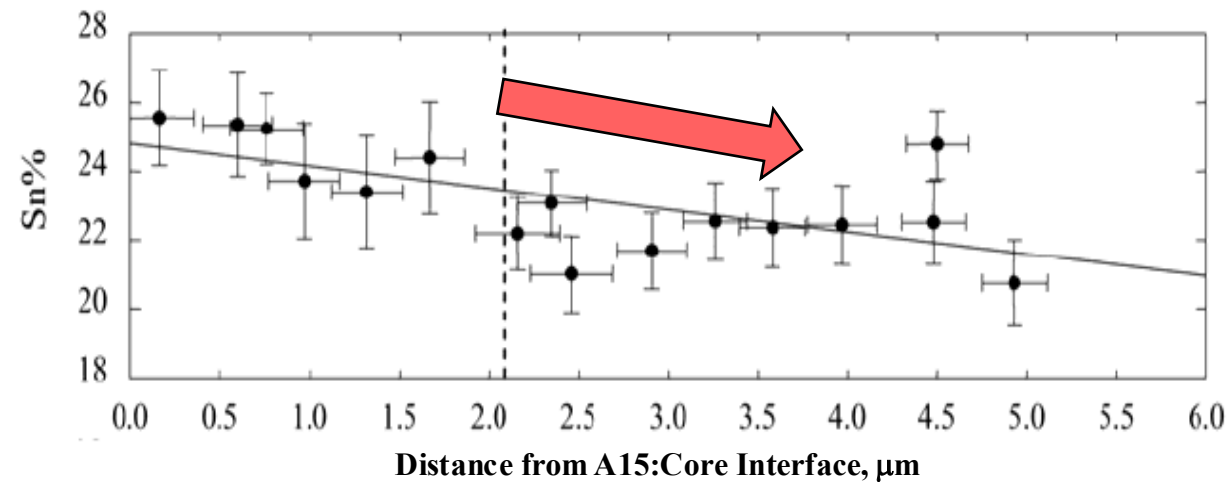
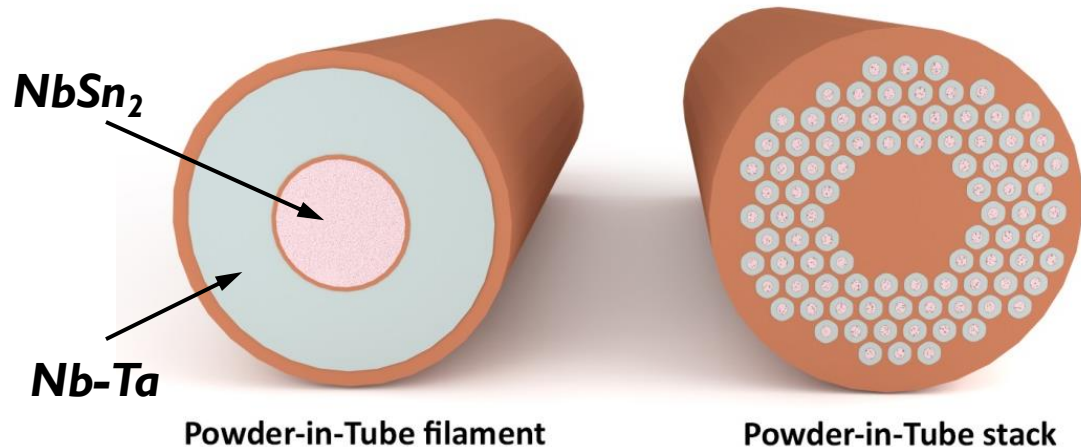


Higher Sn content makes all the grains equiaxed and stoichiometric!

Pictures from C. Sanabria, PhD Thesis (2017), FSU

Another wire fabrication method: Powder In Tube (PIT)

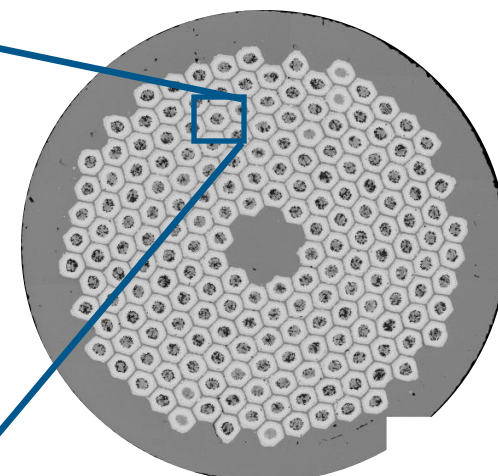
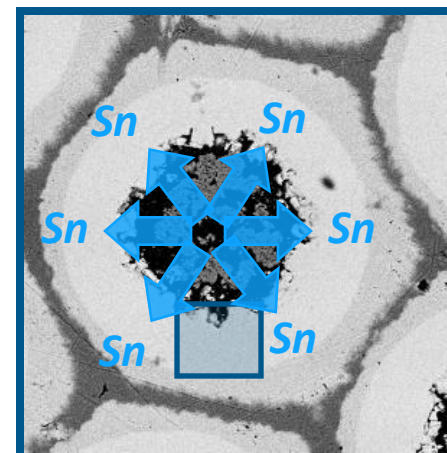
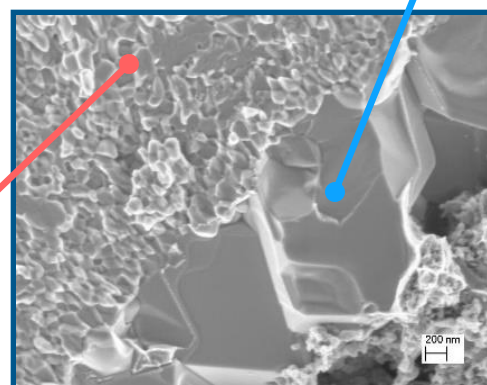
Sn content decreases
linearly along the
filament radius



A Nb tube is filled with NbSn_2 powders, which is used as Sn source in the subelement

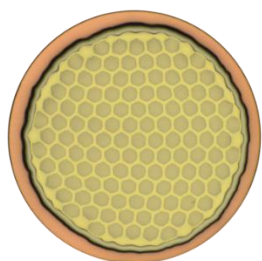
Fine grains
($\sim 200 \text{ nm}$)
 $\sim 23 \text{ at.}\% \text{ Sn}$

Large grains
($> 1 \mu\text{m}$)



Pictures from C. Sanabria,
PhD Thesis (2017), FSU

Performances in industrial wires



Bronze Process

Bronze is the Sn source, limited by the solubility of Sn in Cu

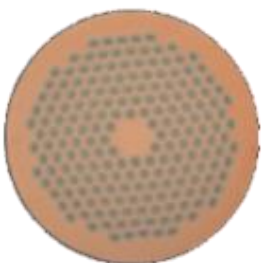
V. Abächerli et al. IEEE TASC (2007) 17 2564



Internal Sn / RRP

A metallic Sn rod is inserted in the subelement core

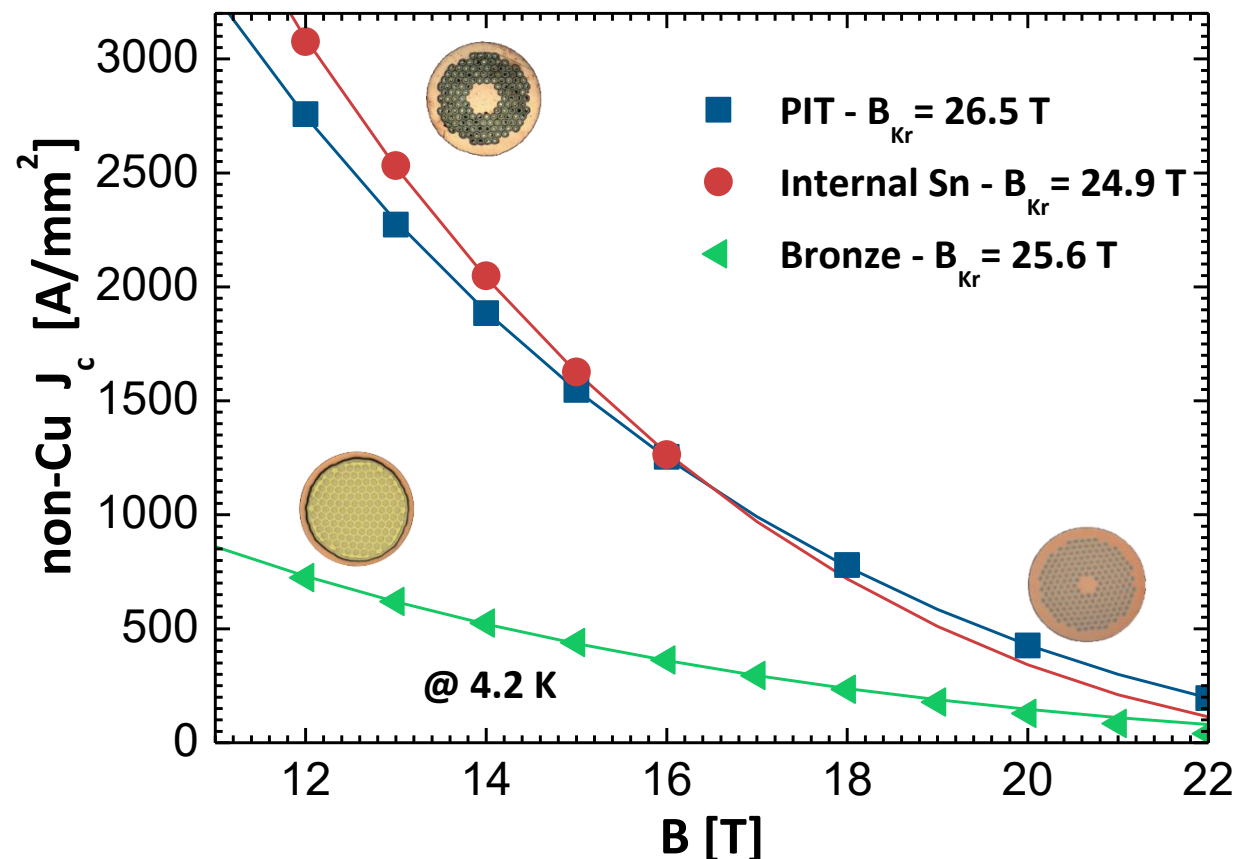
J. Parrell et al. AIP Conf. Proc. (2004) 711 369



Powder-In-Tube (PIT) method

Each subelement is a Nb-alloy tube filled with NbSn₂ and Sn powders

T. Boutboul et al. IEEE TASC (2009) 19 2564



Presently produced by



LUVATA

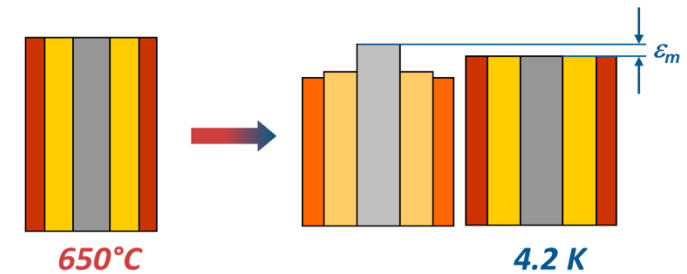
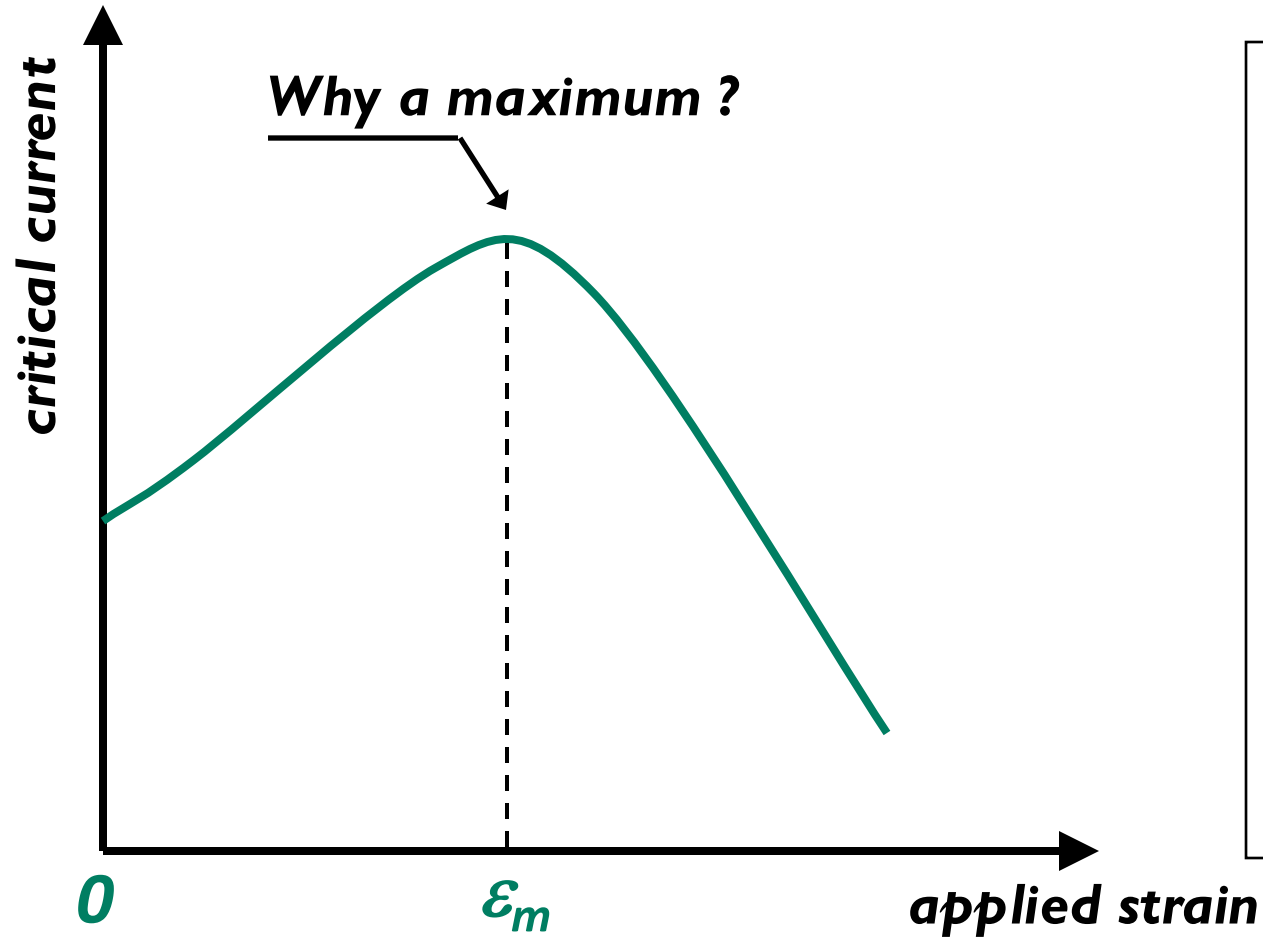
Western Superconducting Technologies Co., Ltd.



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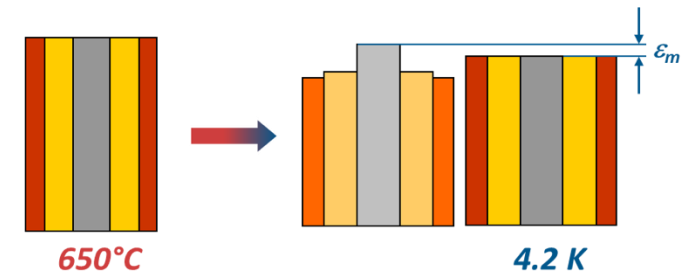
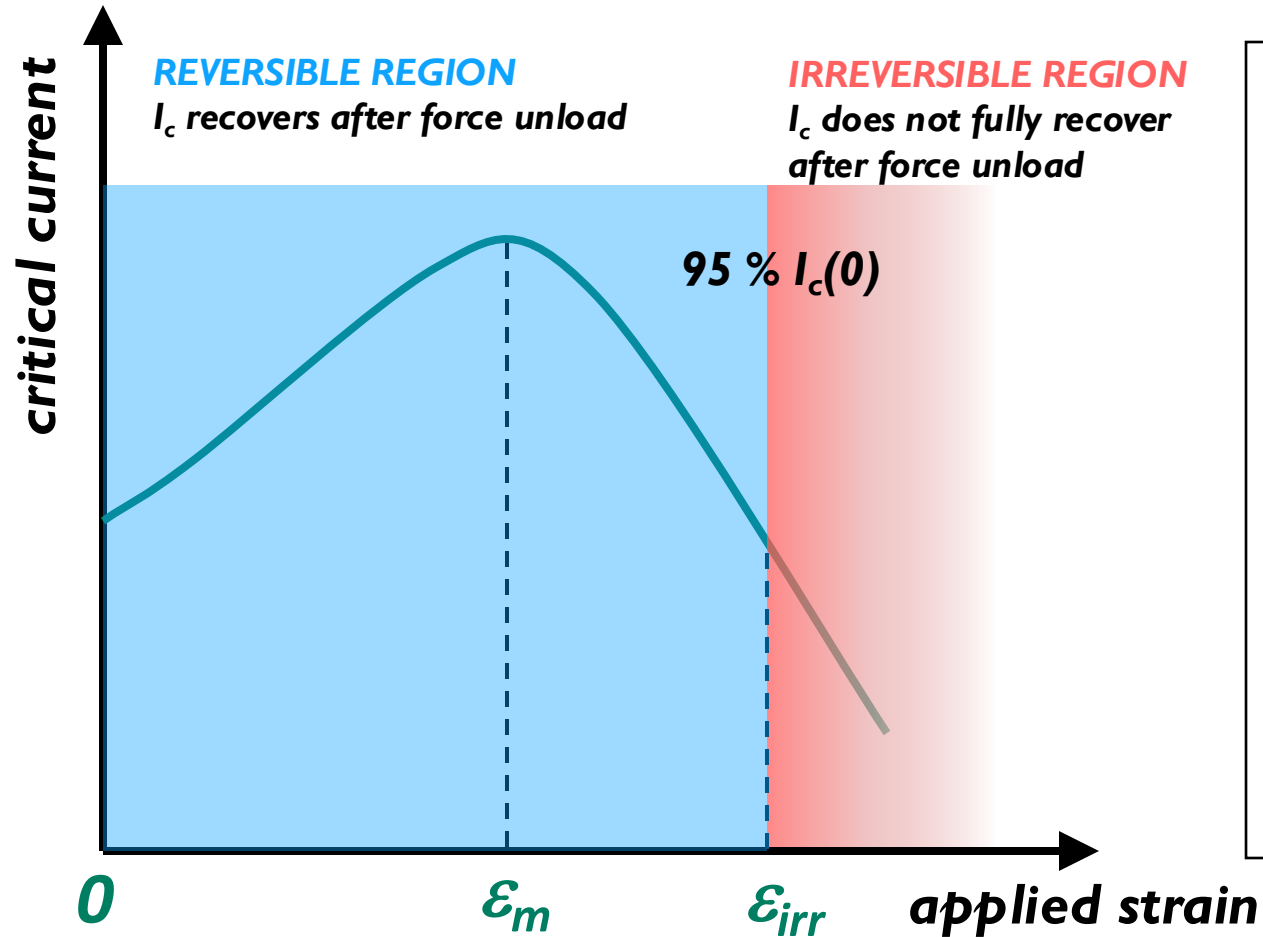
How axial strain modify Nb_3Sn wires J_c



Mismatch in thermal contraction within the composite induces a precompression in Nb_3Sn

The applied strain reduces the effects of the thermal precompression and the critical current increases up to a maximum

How axial strain modify Nb_3Sn wires J_c



Mismatch in thermal contraction within the composite induces a precompression in Nb_3Sn

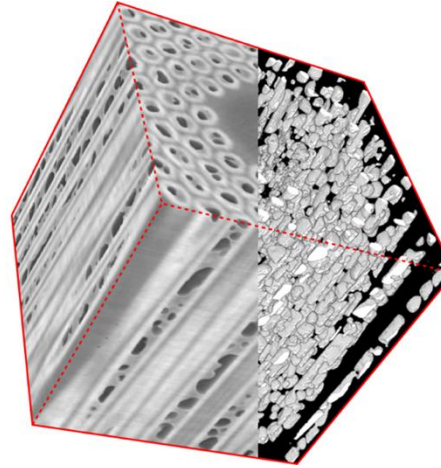
The applied strain reduces the effects of the thermal precompression and the critical current increases up to a maximum

Irreversible degradation phenomena

Two mechanisms govern the irreversible degradation of the critical current

1 - Formation of **cracks** in the Nb_3Sn filaments due to the stress concentration

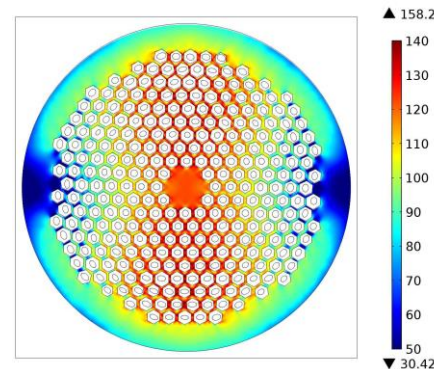
2 - **Plastic deformation** of the matrix and residual stress on the Nb_3Sn filaments.



Analysis of the phenomenon in two load geometries

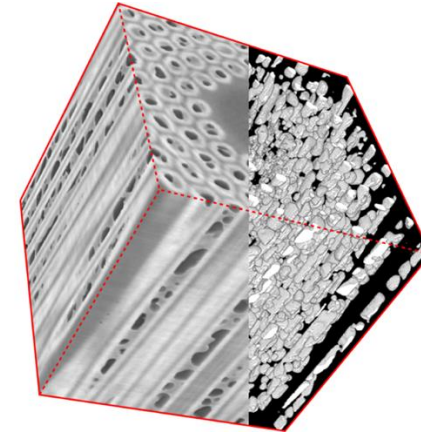
1 – Axial tension and the role of cracks at the voids

2 – Transverse compression, plastic deformation of the matrix and residual stress on Nb_3Sn

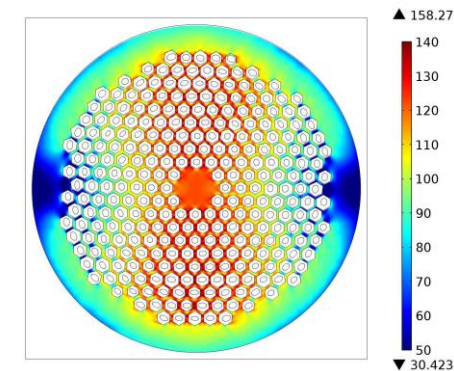


Analysis of the phenomenon in two load geometries

1 – Axial tension and the role of cracks at the voids

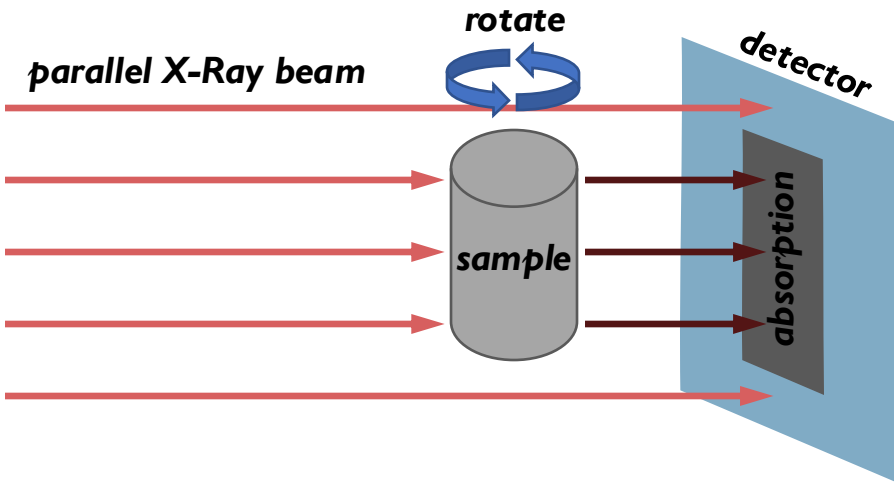


2 – Transverse compression, plastic deformation of the matrix and residual stress on Nb_3Sn



Voids detection in Nb_3Sn wires

X-ray microtomography reconstruction @ ESRF Grenoble



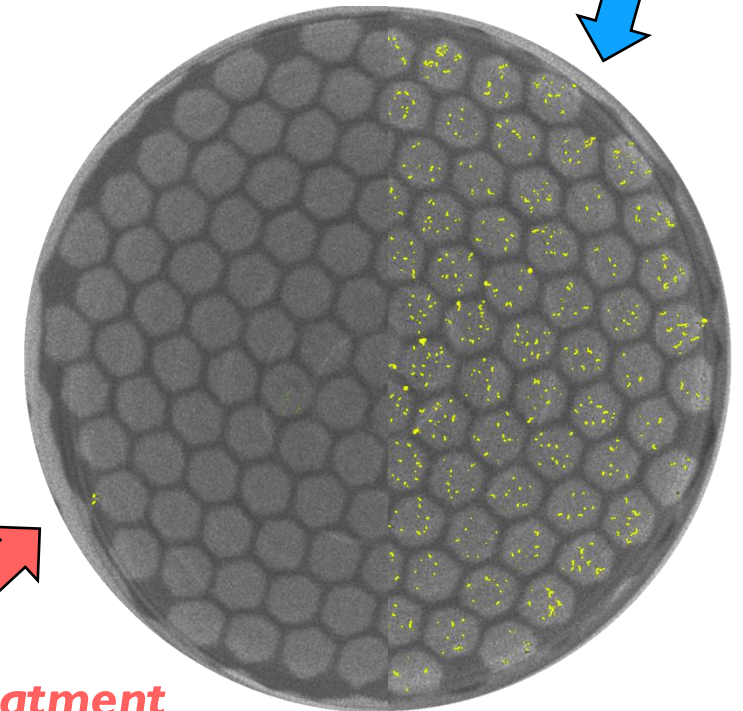
- X-ray photon energy = 89 keV
- 360° rotation of the sample
- 30'000 projections
- 2560 x 2160 pixels
- 0.57 μm /pixel resolution



**Non-destructive 3D
volume reconstruction
with separation of
internal features to
study voids distribution**

Regular HT treatment

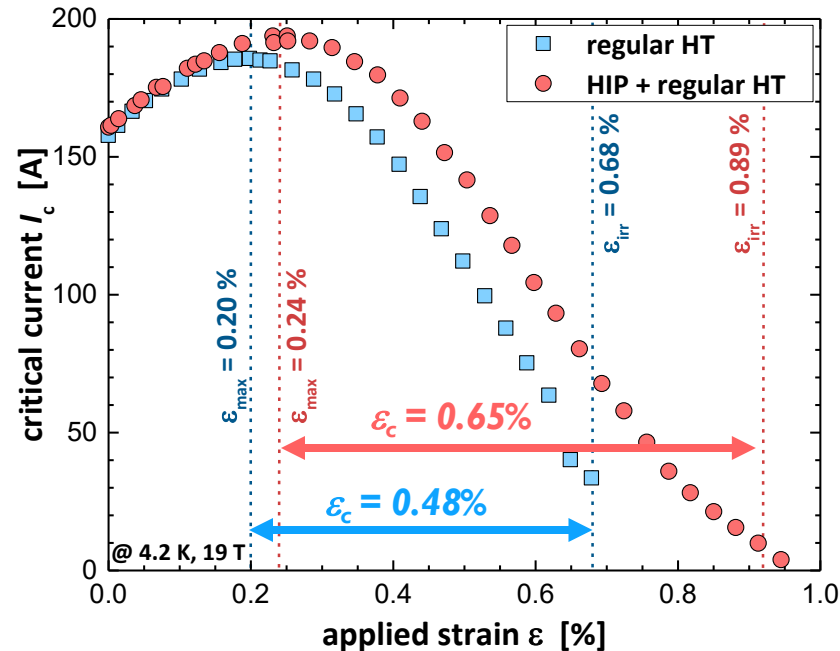
Void fraction = **2.1 %**



With HIP treatment

Void fraction = **0.05 %**

Irreversible limit measurement



Regular HT: 600°C/100h + 670°C/150h

$$\varepsilon_c = \varepsilon_{\text{irr}} - \varepsilon_{\max} = 0.48\%$$

HIP 550°C/1h/200MPa + Regular HT

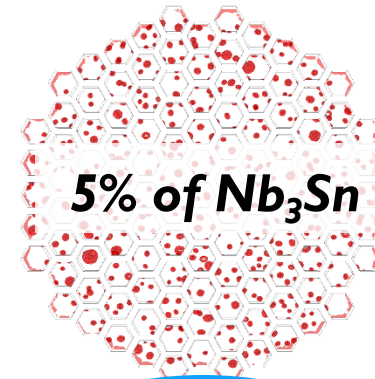
$$\varepsilon_c = \varepsilon_{\text{irr}} - \varepsilon_{\max} = 0.65\%$$

With HIP treatment ε_c increases by +0.17 %

FEM simulations

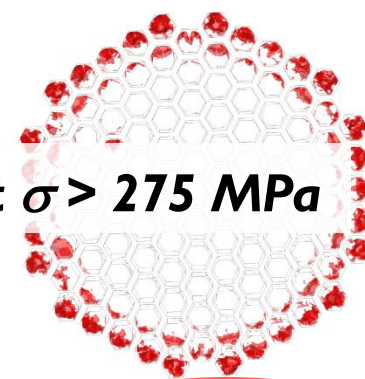
with voids

without voids



5% of Nb_3Sn at $\sigma > 275 \text{ MPa}$

$$\varepsilon_c = 0.50\%$$



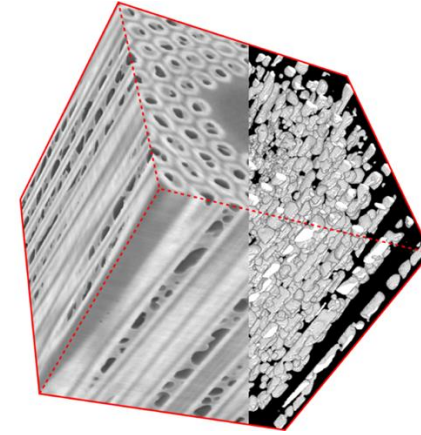
$$\varepsilon_c = 0.65\%$$

C. Barth et al. Sci. Rep. (2018) 8 6589

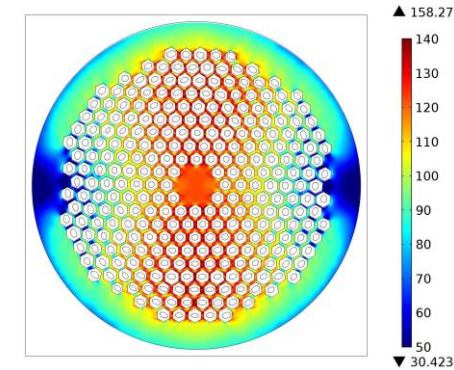
Changes in the voids correlate quantitatively with the changes in the electromechanical limits

Analysis of the phenomenon in two load geometries

1 – Axial tension and the role of cracks at the voids

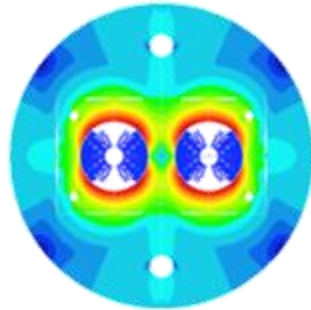


2 – Transverse compression, plastic deformation of the matrix and residual stress on Nb₃Sn

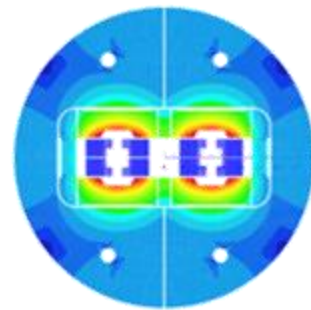


Design options for the FCC-hh dipoles

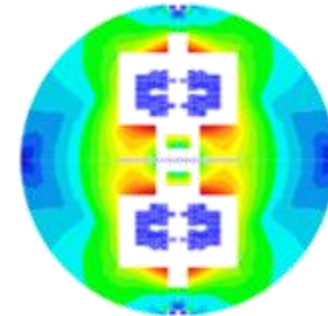
h2020 EuroCirCol WP5,
started in 2015



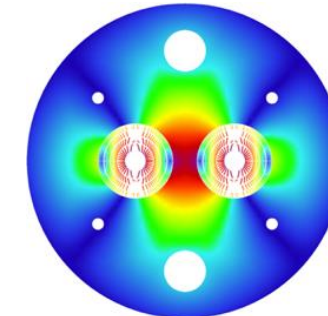
Cosine Theta Coil



Block Coil

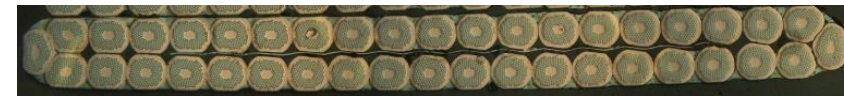


Common Coil



Canted Cosine Theta (CCT)

All designs for the **16 T** dipoles share a peak in **transverse stress** at operation of **150-200 MPa**

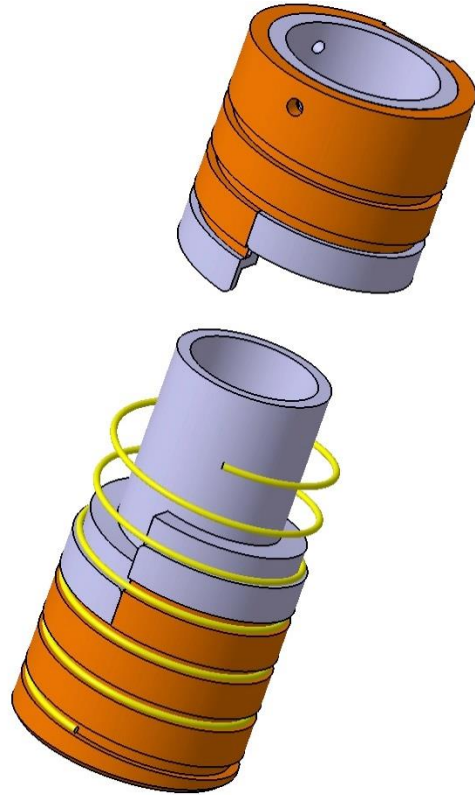


Nb_3Sn Rutherford cable for HL-LHC, 40 strands

Are the Nb_3Sn wires in the Rutherford cables able to withstand such a high stress level? Which degradation is tolerable?

I_c vs. transverse stress on a single wire

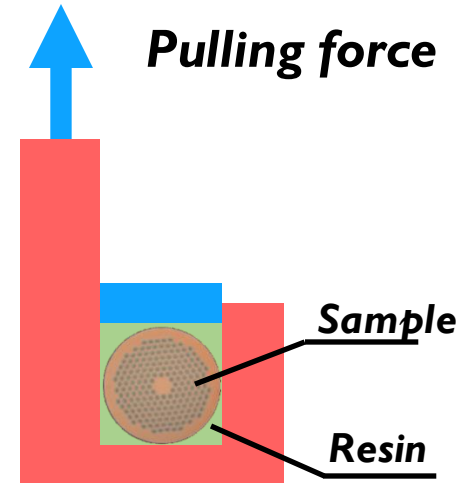
The WASP concept



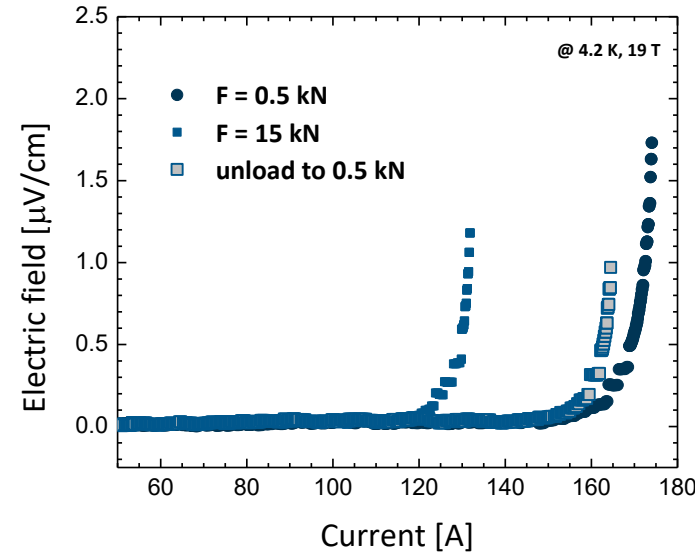
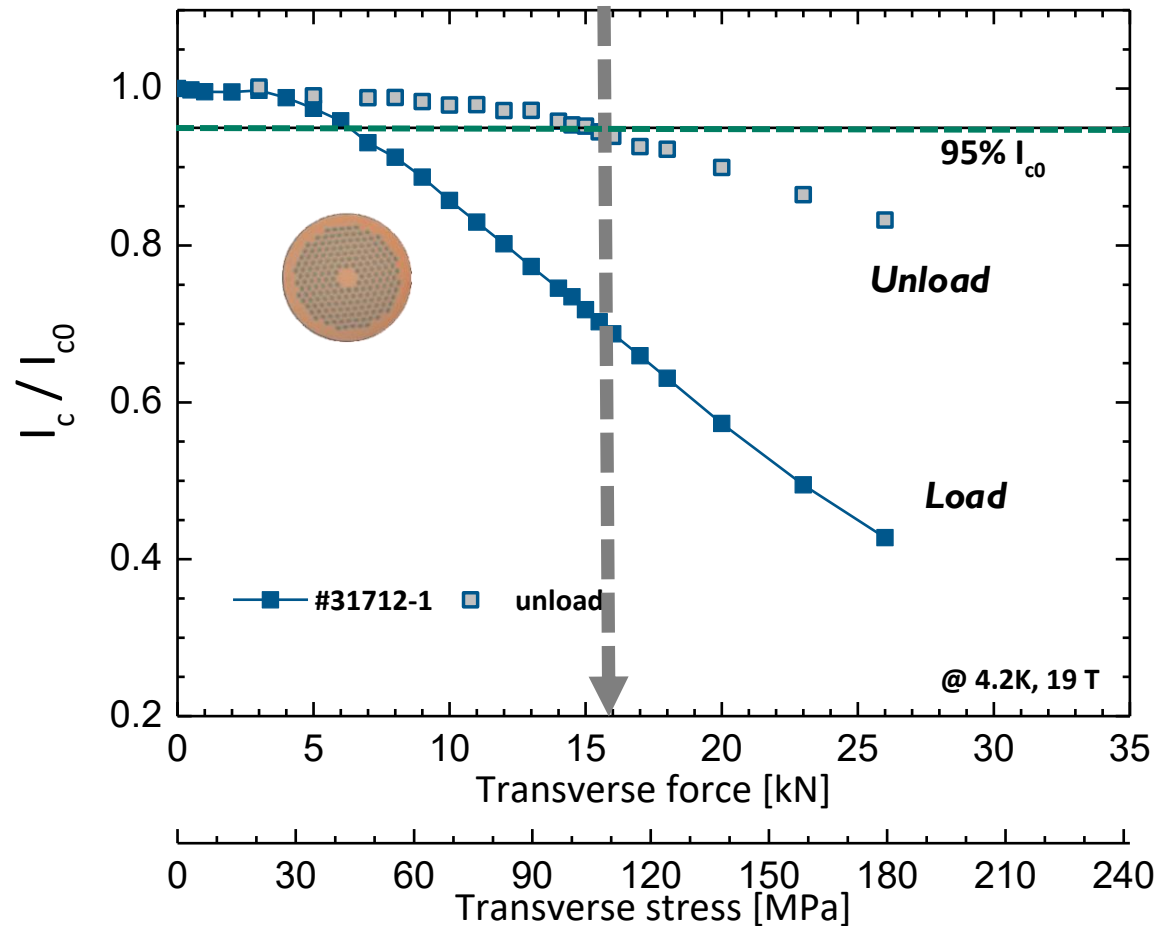
B. Seeber et al. *IEEE TASC* (2007) 17 2643

G. Mondonico et al. *SuST* (2012) 25 115002

4-WALL + impregnation



I_c vs. transverse stress on a single wire



The irreversible limit is defined at the force level leading to a 95% recovery of the initial I_c after unload

Here
 $F_{irr}(B=19T) = 16 \text{ kN}$

The corresponding irreversible stress limit is

$\sigma_{irr}(B=19T) = 110 \text{ MPa}$

where

$$\text{Stress} = \frac{\text{Force}}{\text{Groove length} \times \text{width}}$$

I_c vs. transverse stress on a single wire

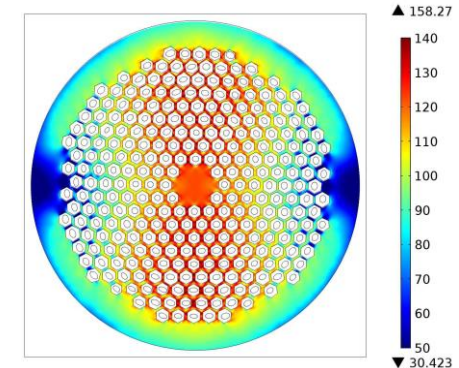
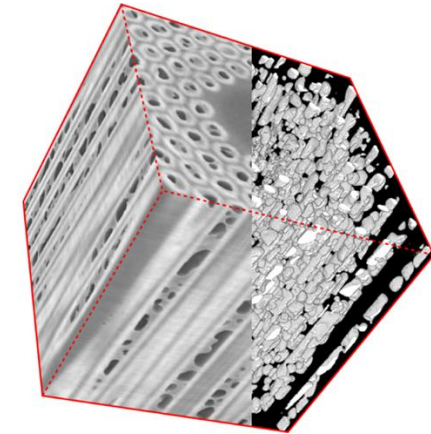
Two mechanisms govern the irreversible degradation of the critical current

- ❑ Formation of **cracks** in the Nb_3Sn filaments due, for instance, to the stress concentration at the voids formed during the reaction heat treatment

Cracks generate a reduction of the current carrying cross section $\Rightarrow I_c^{\text{unload}}/I_{c0}$ is independent of the magnetic field

- ❑ **Plastic deformation** of the matrix and residual stress on the Nb_3Sn filaments.

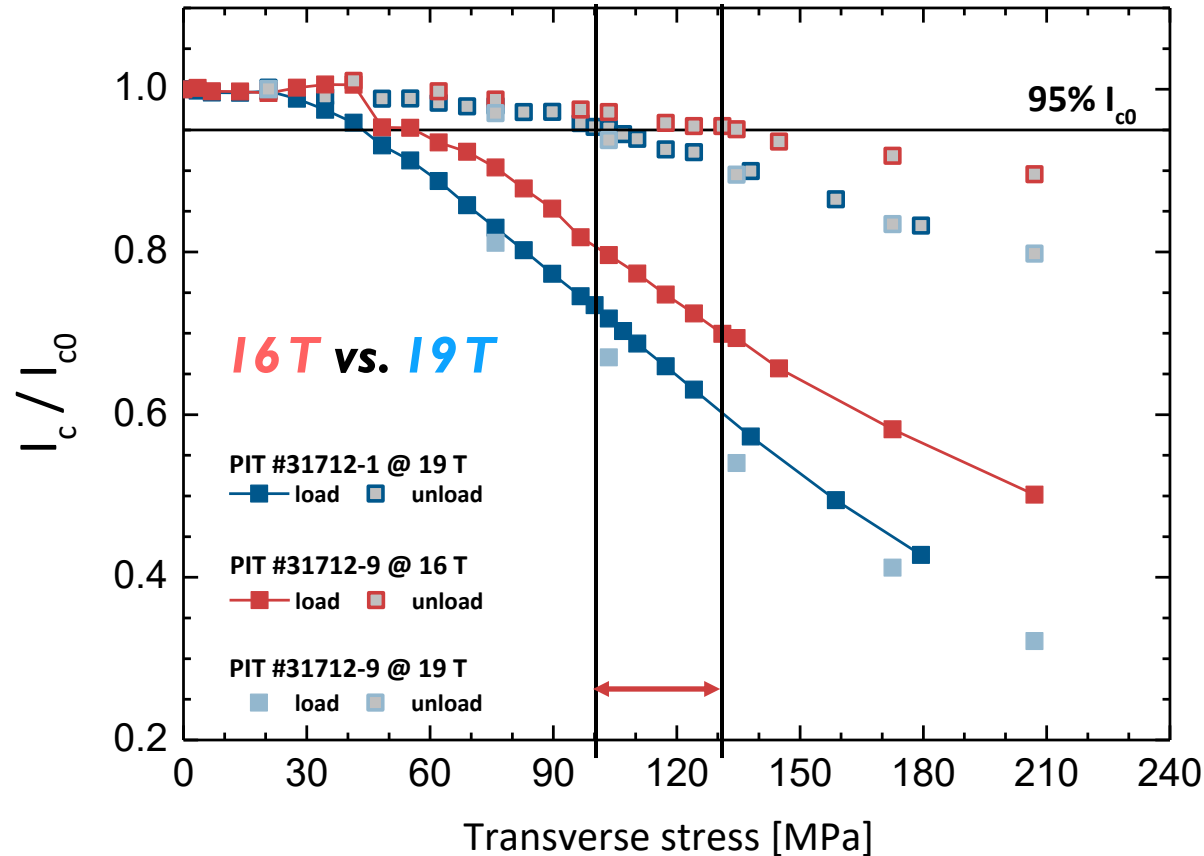
Residual stress induces a permanent reduction of B_{c2} after unload $\Rightarrow I_c^{\text{unload}}/I_{c0}$ depends on of the magnetic field



I_c vs. transverse stress on a single wire

Field dependence of the irreversible stress limit

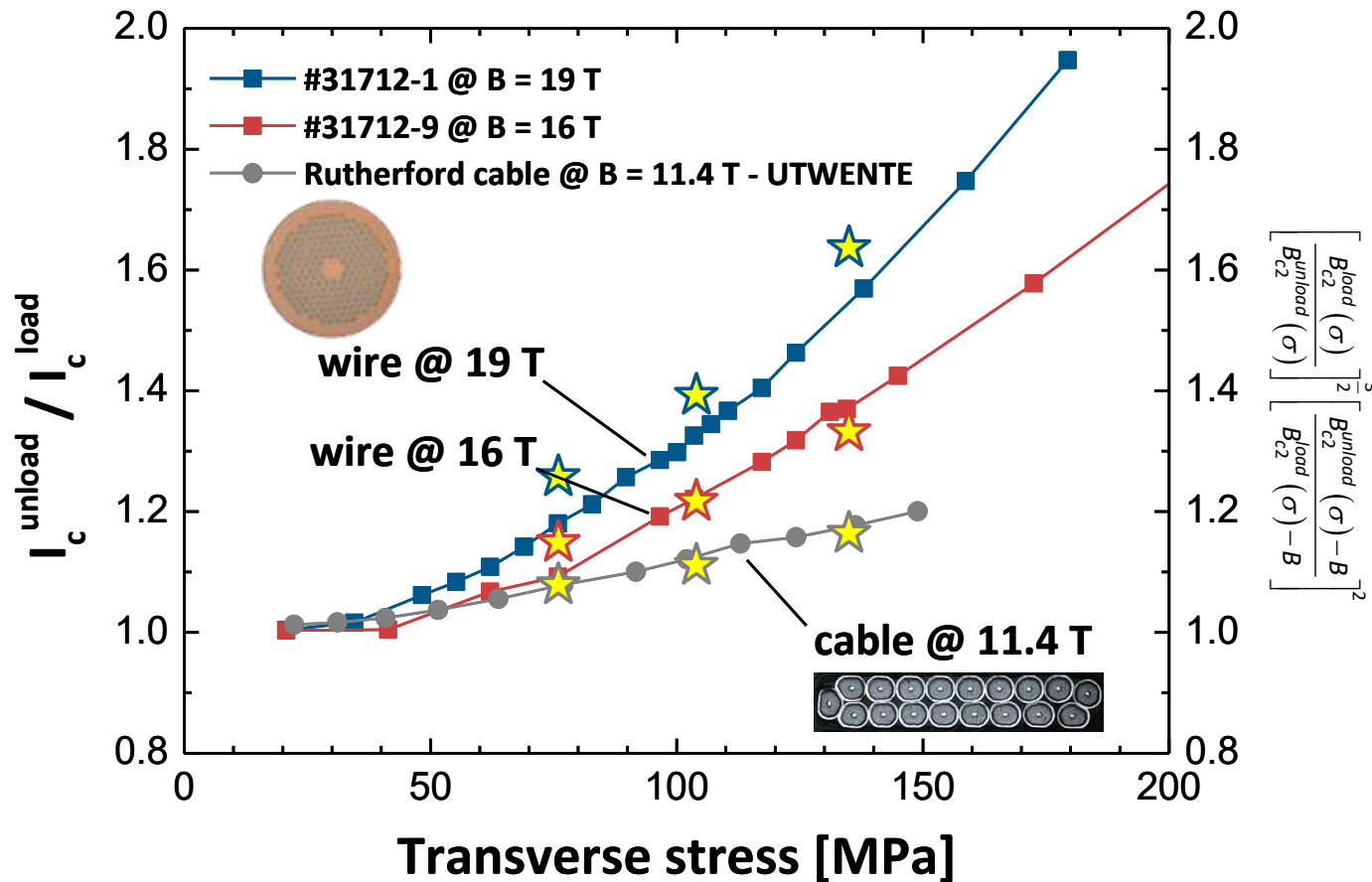
Clear field dependence!



L. Gamperle et al. *Physical Review Research* (2020) 2.1 013211.

I_c vs. transverse stress on a single wire

Field dependence of the irreversible stress limit



Clear field dependence!

A simple model, based only on the effects of residual stress, reproduces the experimental dependences on field and stress

It proves also that the experiments performed on the single wire are consistent with those on cables

$$\left[\frac{B_{c2}^{\text{load}}(\sigma)}{B_{c2}^{\text{unload}}(\sigma)} \right]^2 \left[\frac{B_{c2}^{\text{unload}}(\sigma) - B}{B_{c2}^{\text{load}}(\sigma) - B} \right]^2$$

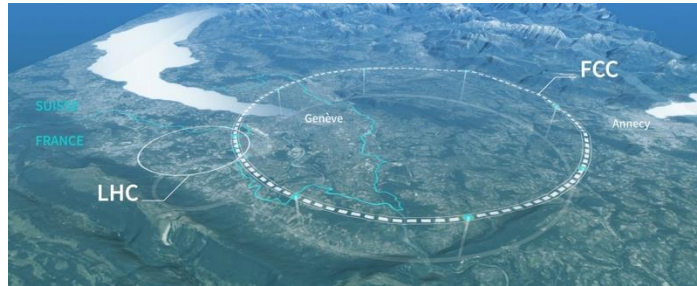
$$\frac{I_c^{\text{unload}}}{I_c^{\text{load}}}(B, \sigma) = \left[\frac{B_{c2}^{\text{load}}(\sigma)}{B_{c2}^{\text{unload}}(\sigma)} \right]^{\frac{3}{2}} \left[\frac{B_{c2}^{\text{unload}}(\sigma) - B}{B_{c2}^{\text{load}}(\sigma) - B} \right]^2$$

L. Gamperle et al. Physical Review Research (2020) 2.1 013211.

Outline

- *A brief history of Nb₃Sn*
- *From bronze to internal Sn wires:
the multifilamentary wires age*
- *J_c and B_{c2} are essential, yet not sufficient for applications*
- **FCC-hh and the new challenges for Nb₃Sn**

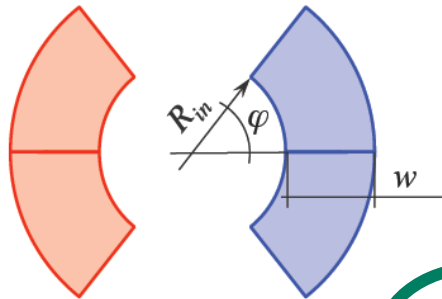
The Future Circular Collider



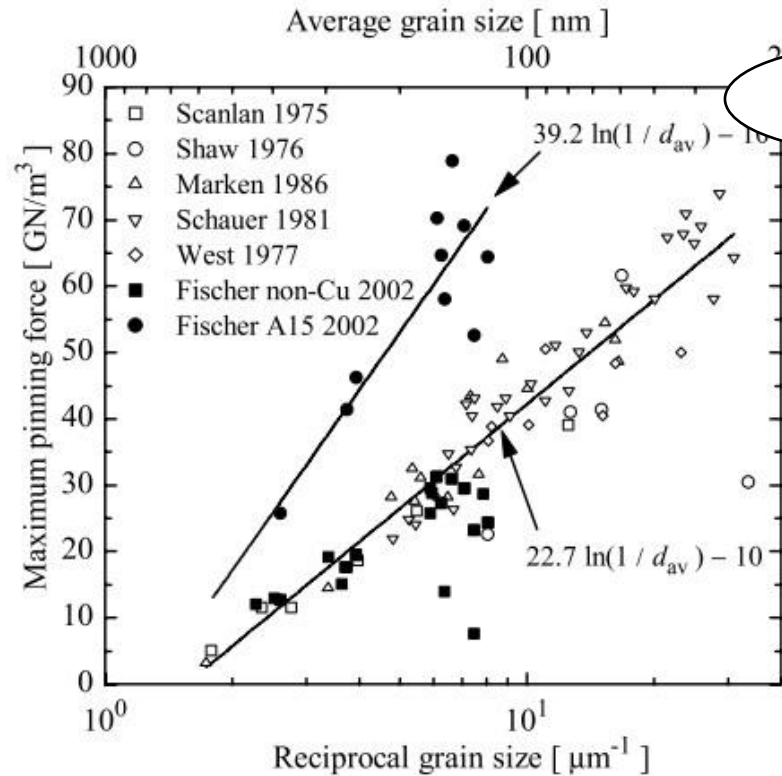
LHC
27 km, 8.33 T
14 TeV (c.o.m.)
1'300 tons NbTi

FCC-hh
91 km, 14 T
~ 85 TeV (c.o.m.)
~10'000 tons Nb₃Sn

A huge amount of Nb₃Sn!!



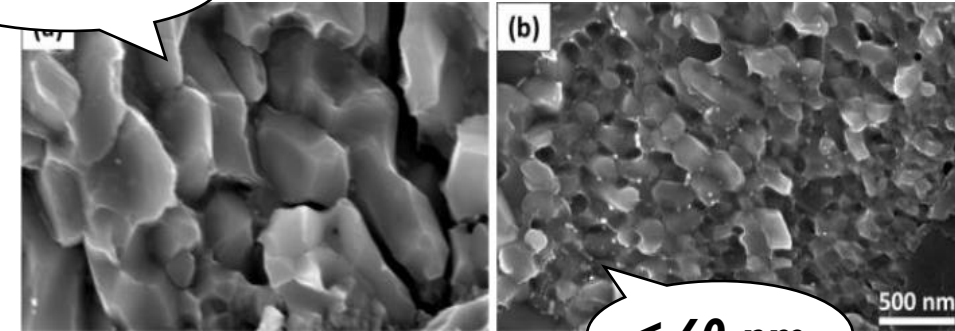
$$A_{coil} = 2\varphi(w + 2R_{int}w) \propto \frac{1}{J}$$



How can we reduce effectively grain size?

> 100 nm

Internal oxidation !

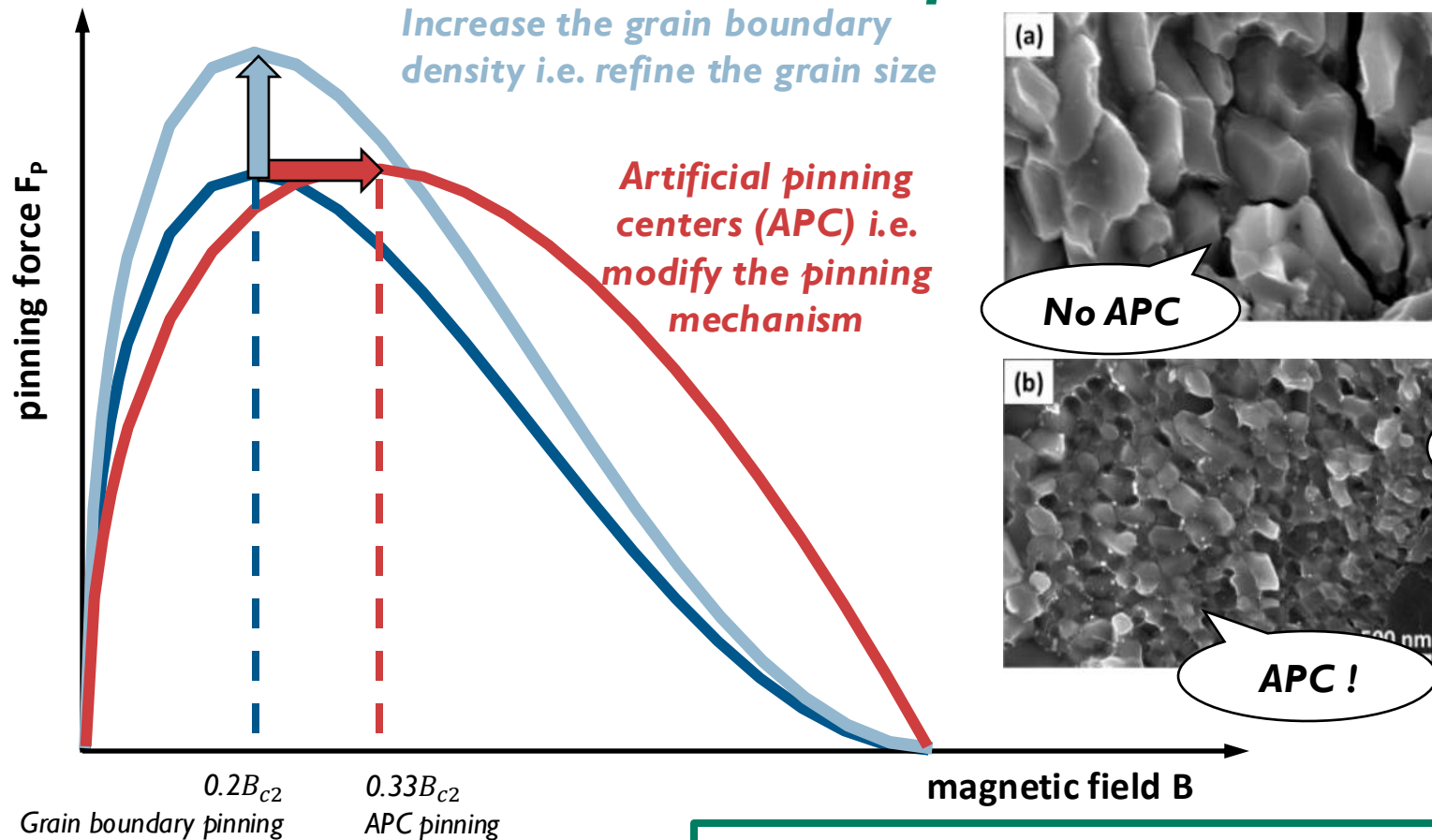


< 60 nm

Grain refinement induced by precipitation of oxides nanoparticles

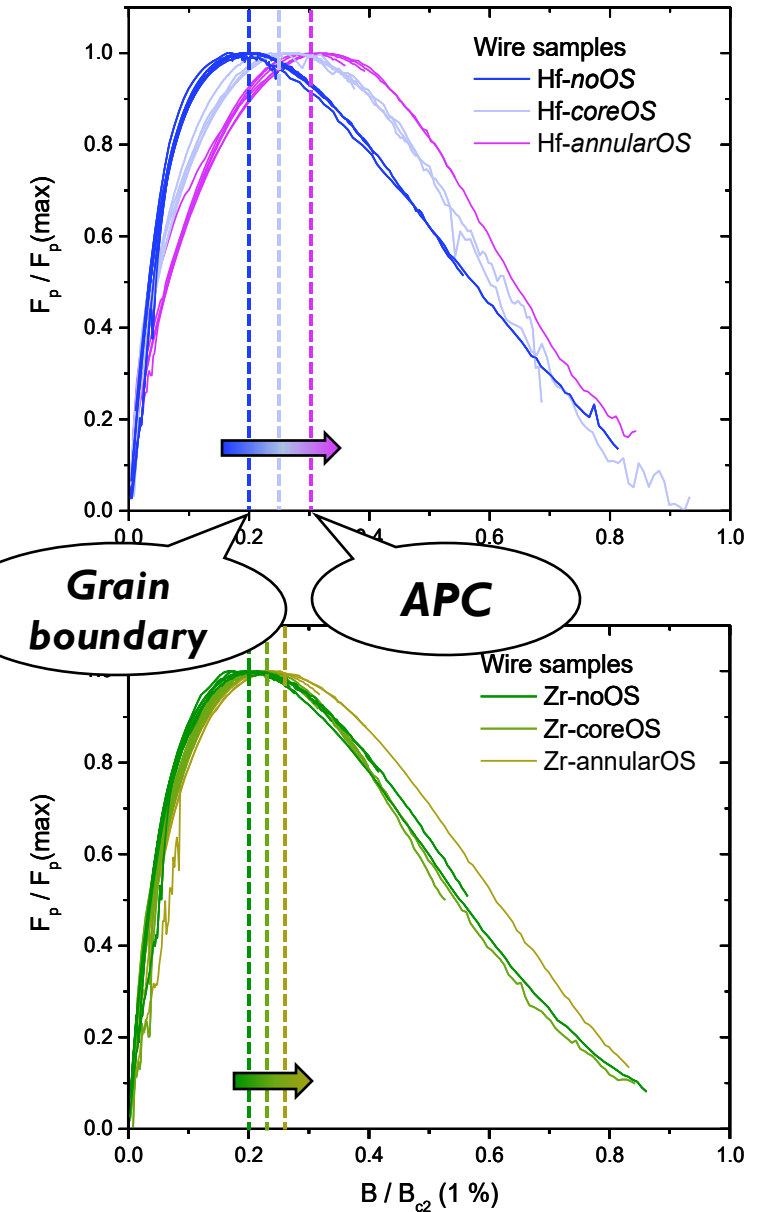
- X. Xu et al. *Appl. Phys. Lett.* (2014) 104, 082602
DOI: [10.1063/1.4866865](https://doi.org/10.1063/1.4866865).
M. G. Benz, *Trans. Met. Soc. AIME*, (1968) 242: 1067-70.
L. E. Rumaner et al. *Metall Mater Trans A* (1994) 25, 213-219
DOI: [10.1007/BF02646689](https://doi.org/10.1007/BF02646689).
A. Godeke, *Supercond. Sci. Technol* (2006) 19 R68
DOI: [10.1088/0953-2048/19/8/R02](https://doi.org/10.1088/0953-2048/19/8/R02)
E. Todesco, *IEEE Transactions on Applied Superconductivity* (2025) DOI: [10.1109/TASC.2025.3558196](https://doi.org/10.1109/TASC.2025.3558196)

More than just a F_p increase



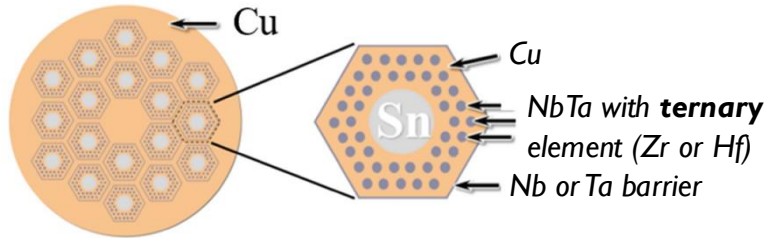
Internal Oxidation leads to grain refinement AND produces Artificial Pinning Centers (APCs)

$$F_p = J_c \times B$$



Internal oxidation process

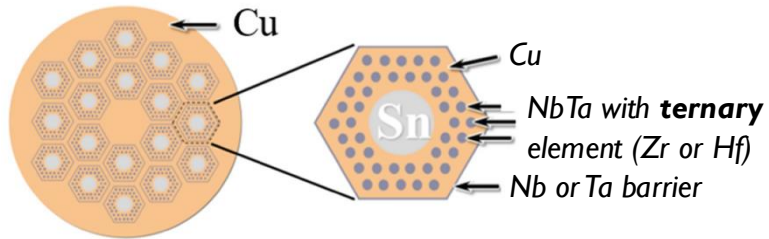
What happens during heat treatment



***During heat treatment, grains
grows and join together when
their boundaries touches***

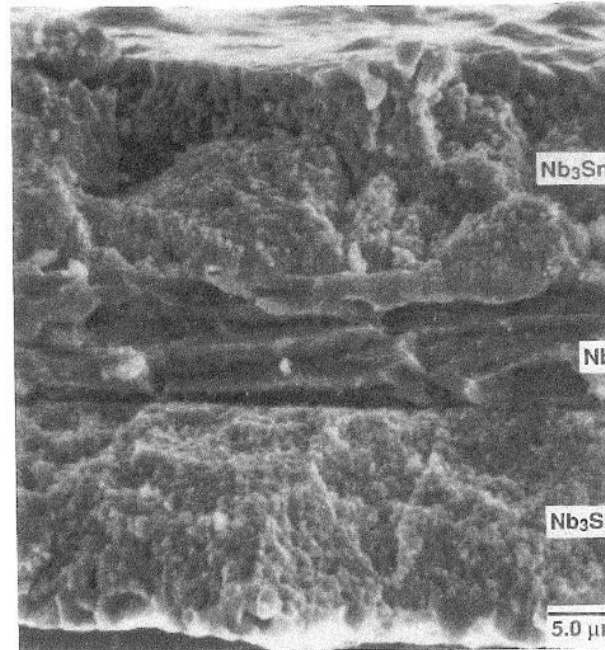
Internal oxidation process

What happens during heat treatment



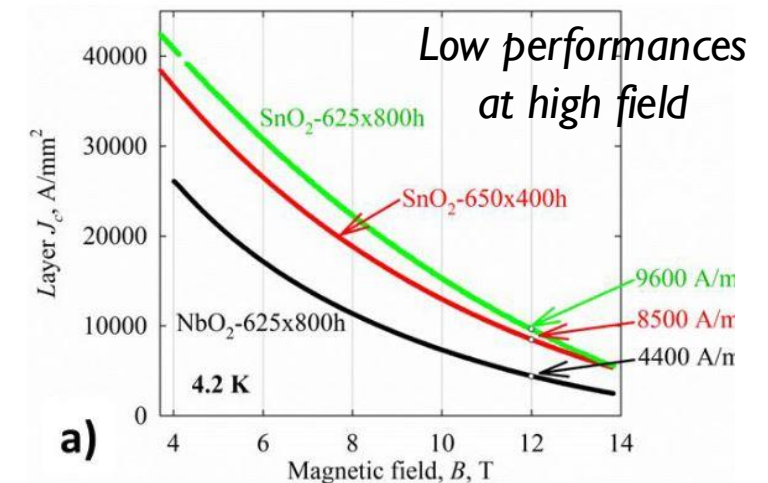
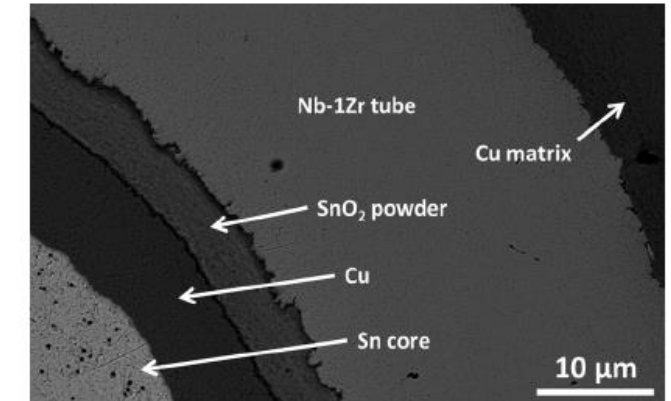
Oxygen reacts with Hf or Zr
(higher oxygen affinity)

ZrO_2 (or HfO_2)
nanoparticles inhibits grain
boundaries movement



Proposed in 1968 on tape samples,
the year before bronze route was
developed. Forgotten for a long
time as considered impossible to
be implemented in wires

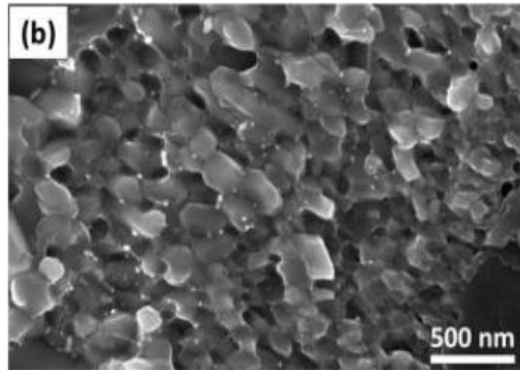
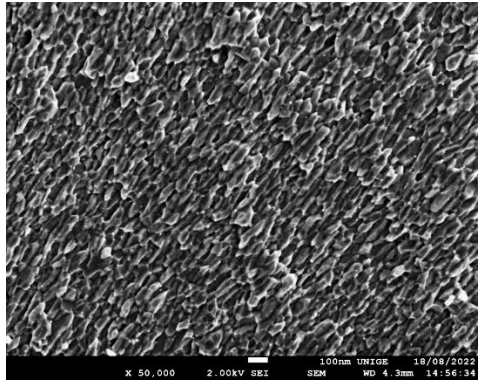
The first wire was fabricated in
2014, using a separate oxygen
source to allow wire deformation



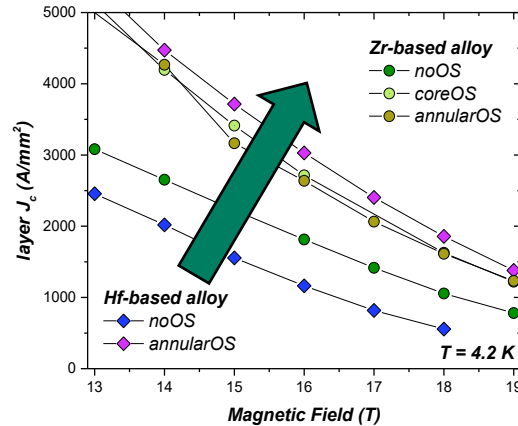
M. G. Benz Transaction of the Metal. Soc. of AIME (1968) 242
X. Xu et al. Applied Physics Letters (2014) 104.8 082602

The benefits of internal oxidation

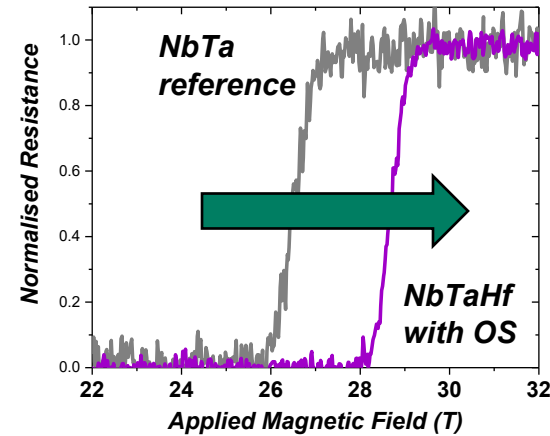
Grain refinement induced by precipitation of oxides nanoparticles



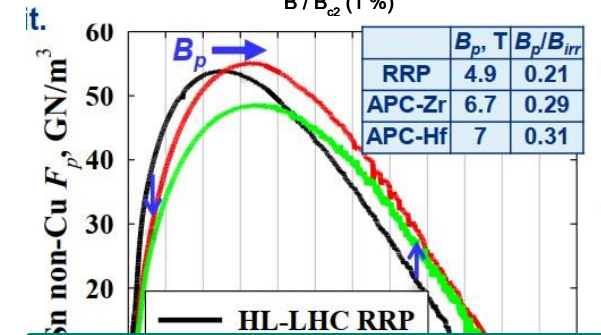
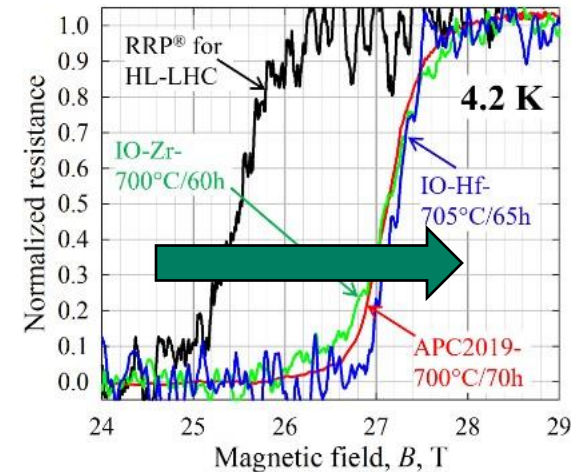
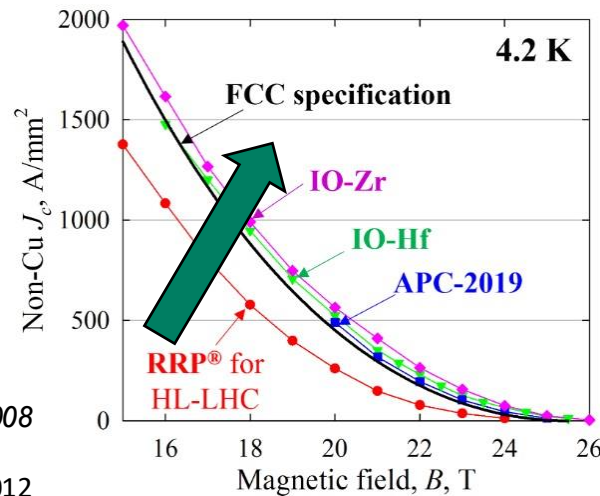
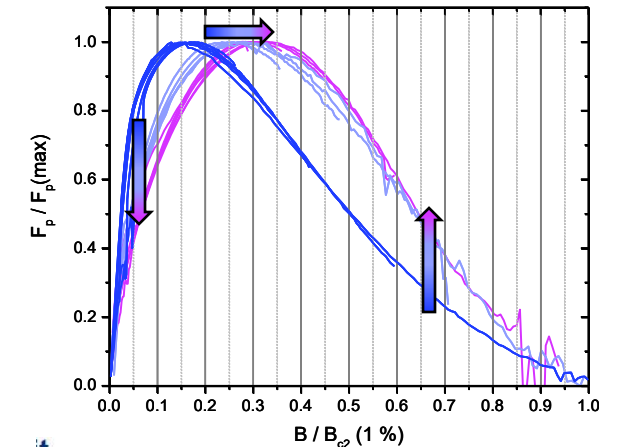
Higher J_c induced by finer Nb_3Sn grains



Higher B_{c2} that contribute to enhance J_c



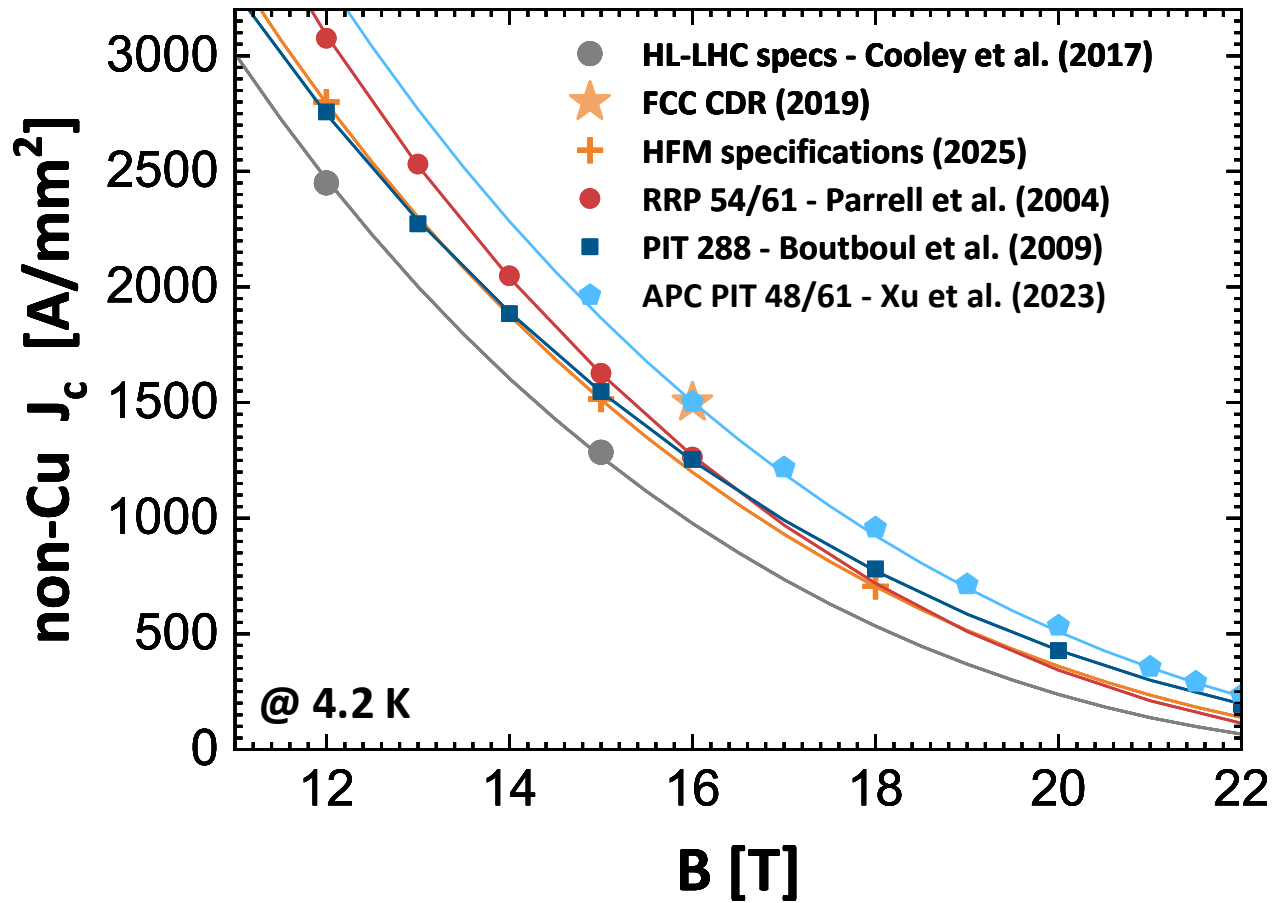
Modification of pinning mechanism



Results confirmed by different groups in multiple studies

X. Xu et al. *Supercond. Sci. Technol.* (2023) 36 085008
DOI: [10.1088/1361-6668/acdf8c](https://doi.org/10.1088/1361-6668/acdf8c).
X. Xu et al. *Supercond. Sci. Technol.* (2023) 36 035012
DOI: [10.1088/1361-6668/acb17a](https://doi.org/10.1088/1361-6668/acb17a)

Specifications for FCC-hh



The best non-Cu J_c values for RRP and PIT wires meet the HFM specifications

Prototype PIT wires with internal oxidation (APC) exhibit even higher non-Cu J_c

Improved conductor performance could either reduce the coil size at a given field or enable higher fields

Cooley et al., IEEE TASC 27 (2017) 6000505

Abada et al., Eur. Phys. J. Special Topics 228 (2019) 755–1107

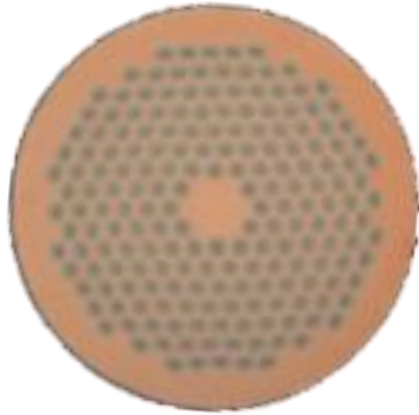
Todesco, HFM Forum (2025), URL: indico.cern.ch/event/1501797/

Parrell et al., AIP Conf. Proc. 711 (2004) 369

Boutboul et al., IEEE TASC 19 (2009) 2564

Xu et al., Supercond. Sci. Tech. 36 (2023) 035012

Manufacturing process: RRP vs PIT



Nb_3Sn multifilamentary wire are not created equal!

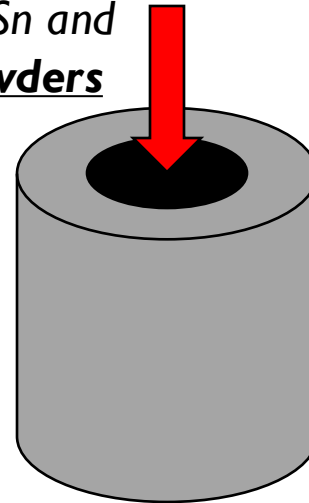
The nature of the wire sub-unit (Subelement) matters!

Remember, internal oxidation requires the addition of oxide powders!

PIT wires

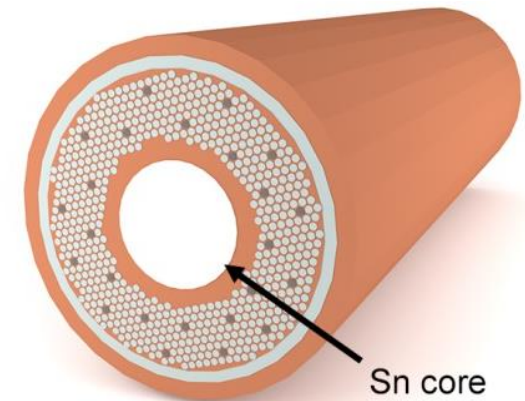


Mix of Cu, Sn and SnO_2 powders



Easier route to introduce powders

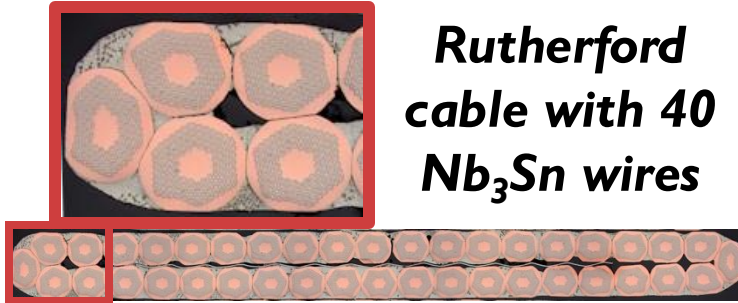
RRP wires



Powders not present in wire layout

Pictures from C. Sanabria, PhD Thesis (2017), FSU

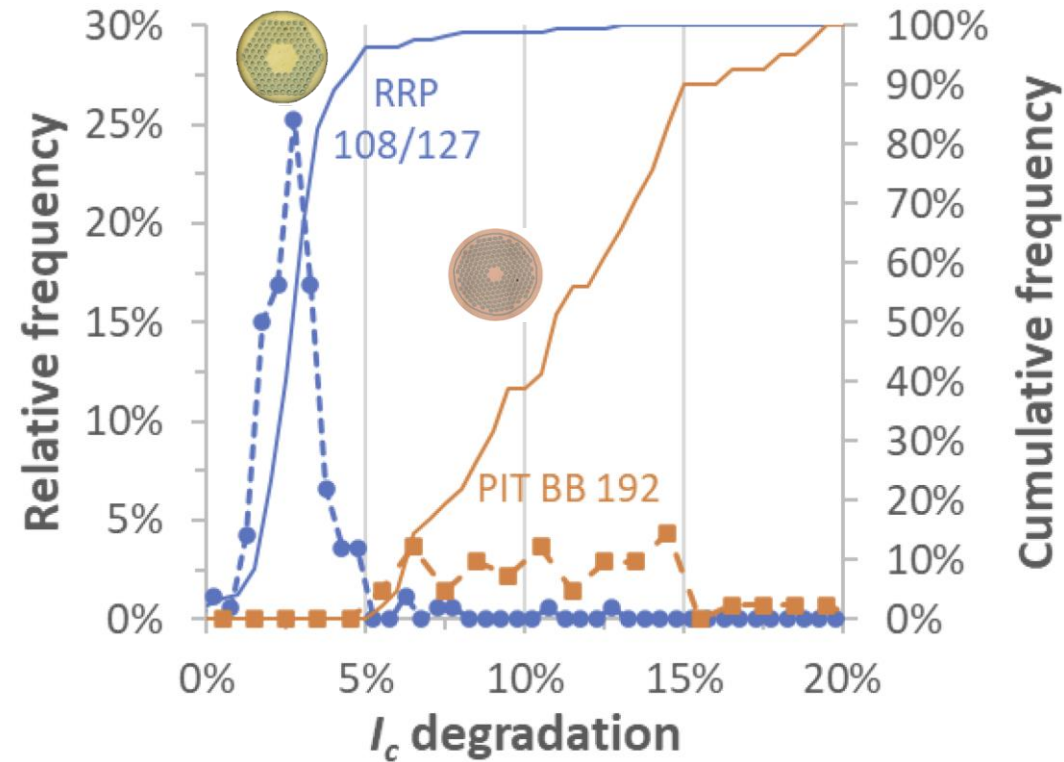
Manufacturing process: RRP vs PIT



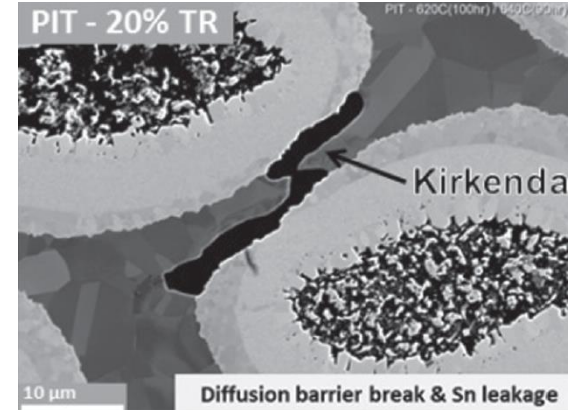
**Rutherford
cable with 40
Nb₃Sn wires**



**Section of a Nb₃Sn
dipole magnet**



**Lower cabling degradation
in Internal Sn RRP wires
compared to PIT wires**



*Distorted filaments produce
Sn leak. Reaction is not
complete, leading to the lower
 I_c and Cu contamination*

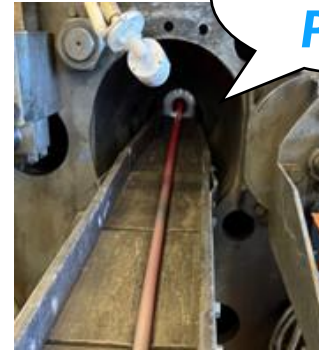
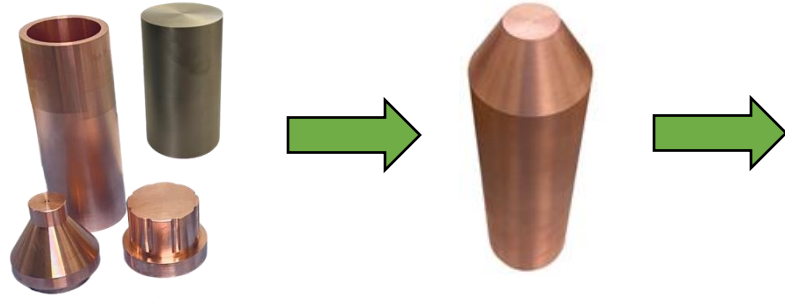
S. Hopkins et al. *IEEE Trans. Appl. Supercond.* **34** (2024) 6001308 DOI: [10.1109/TASC.2024.3375274](https://doi.org/10.1109/TASC.2024.3375274)

M. Brown et al. *Supercond. Sci. Technol.* **29** (2016) 084008 DOI: [10.1088/0953-2048/29/8/084008](https://doi.org/10.1088/0953-2048/29/8/084008)

C. Segal et al. *Supercond. Sci. Technol.* **29** (2016) 085003 DOI: [10.1088/0953-2048/29/8/085003](https://doi.org/10.1088/0953-2048/29/8/085003)

How it's made: high- J_c RRP Nb_3Sn wire

1. Filament processing



Critical Point!

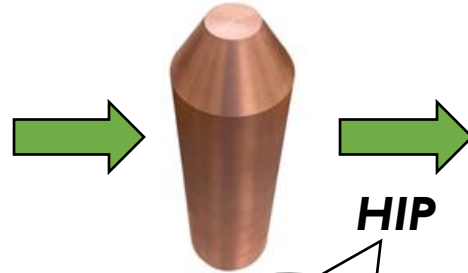
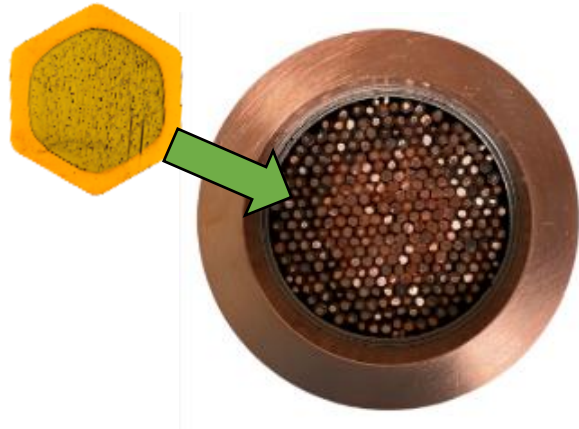
Cold Deformation



RRP wire production involves **hot extrusion**, **hot isostatic pressing** and **cold deformation**

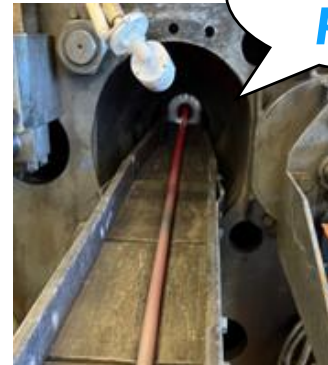
Hot Extrusion

2. Subelement processing



HIP

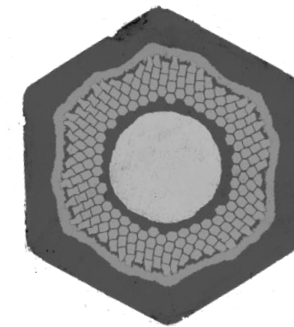
Critical Point!



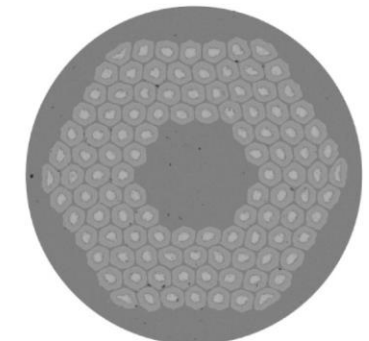
Hot Extrusion

Critical Point!

3. Wire processing



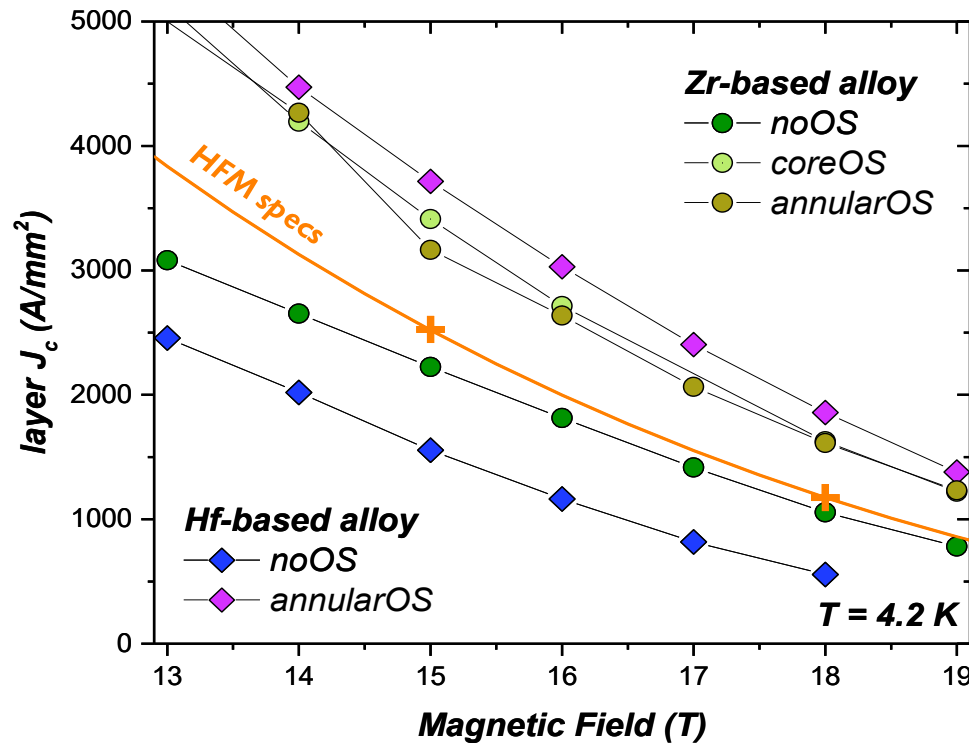
Sn rod insertion and cold deformation



Subelement restack and cold deformation to final diameter

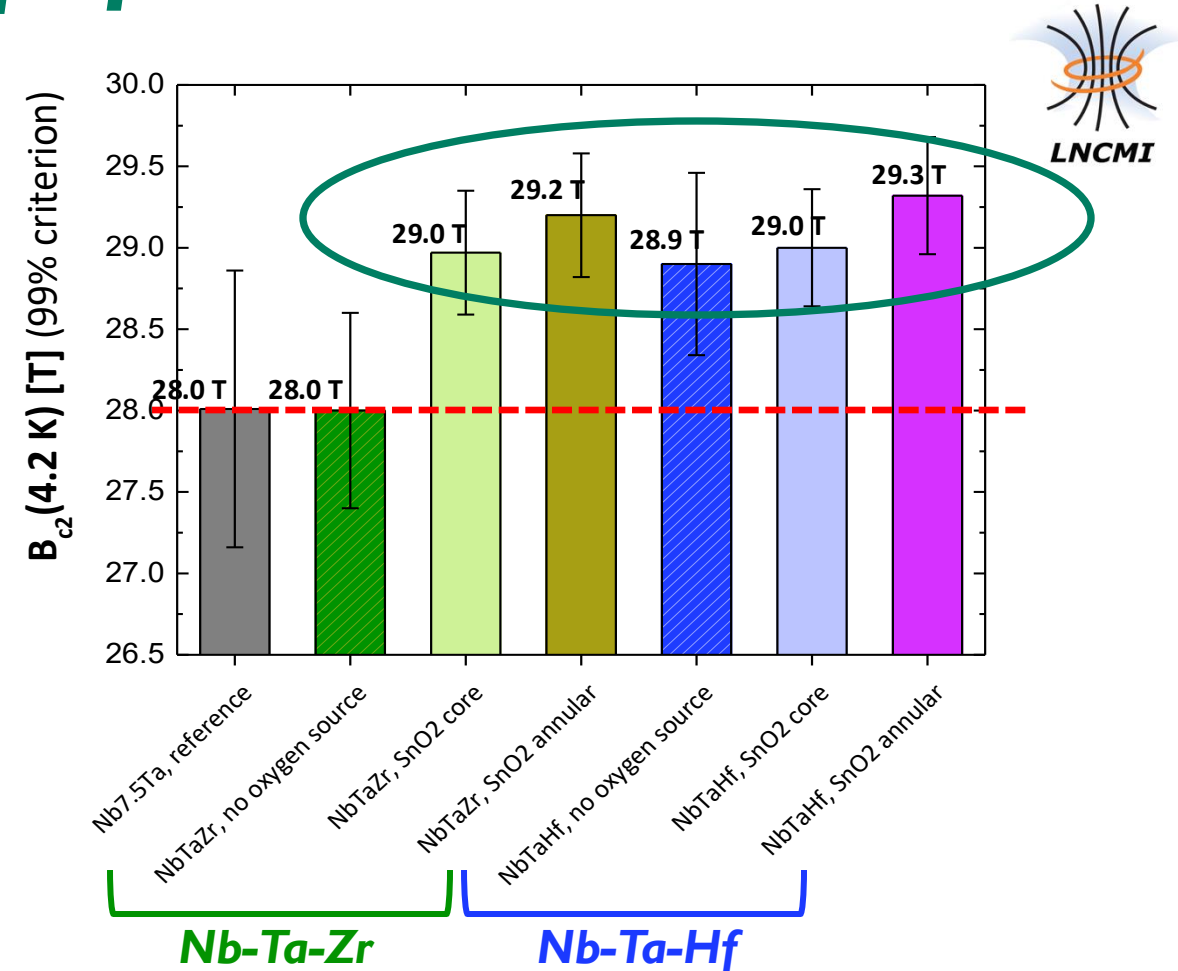
Internal oxidation in simplified RRP wires

Transport I_c and B_{c2} measurements



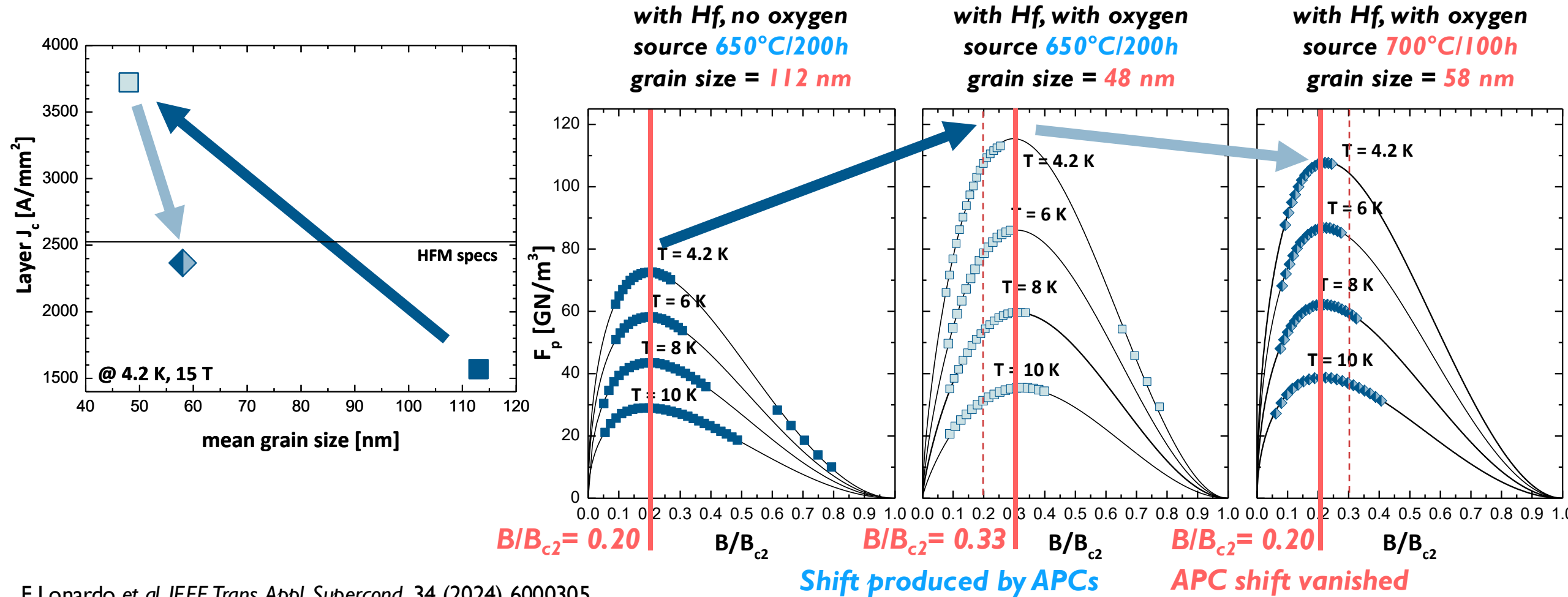
Layer J_c determined from transport measurements

G. Bovone et al. *Supercond. Sci. Tech.* **36** (2023) 095018
DOI: [10.1088/1361-6668/aced25](https://doi.org/10.1088/1361-6668/aced25)



R(B) tests performed up to 33 T at LNCMI-Grenoble show record high B_{c2} values achieved both with Hf and Zr

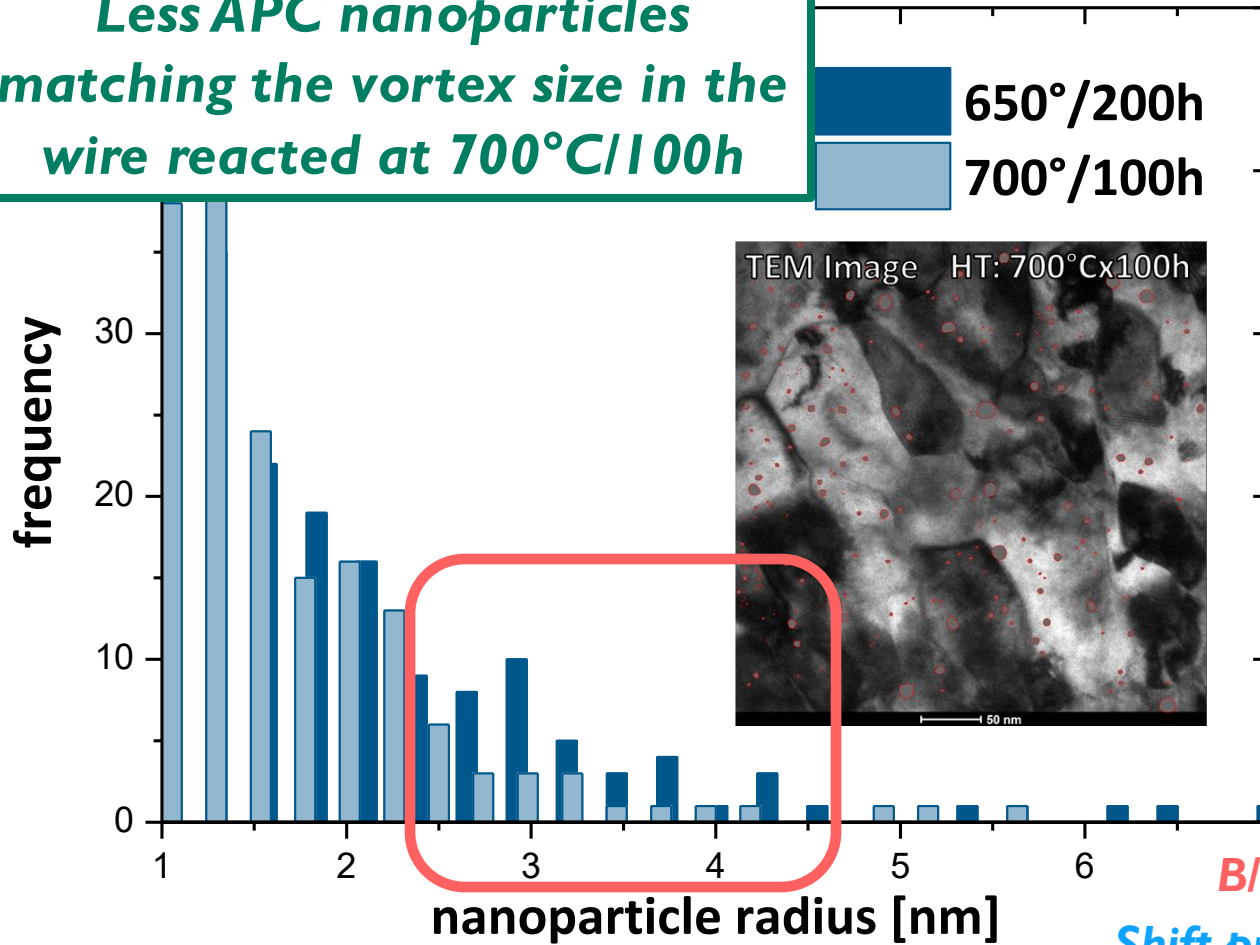
The size of APC nanoparticles matters



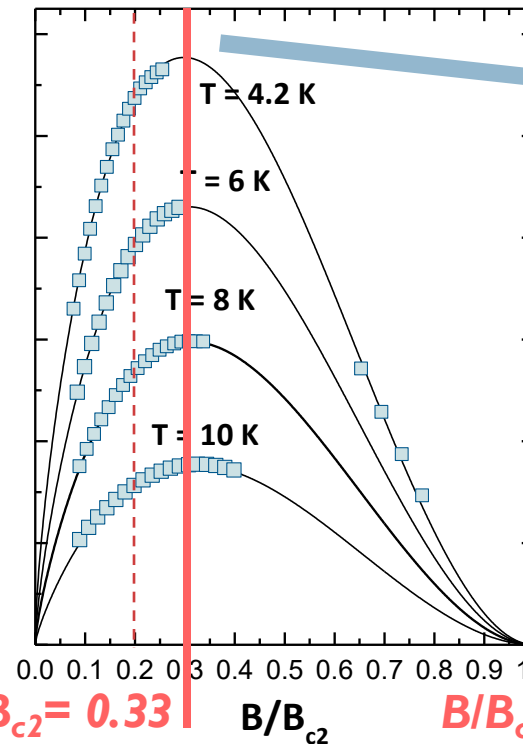
F. Lonardo et al. *IEEE Trans. Appl. Supercond.* **34** (2024) 6000305
DOI: [10.1109/TASC.2024.3355353](https://doi.org/10.1109/TASC.2024.3355353)

The size of APC nanoparticles matters

Less APC nanoparticles matching the vortex size in the wire reacted at 700°C/100h

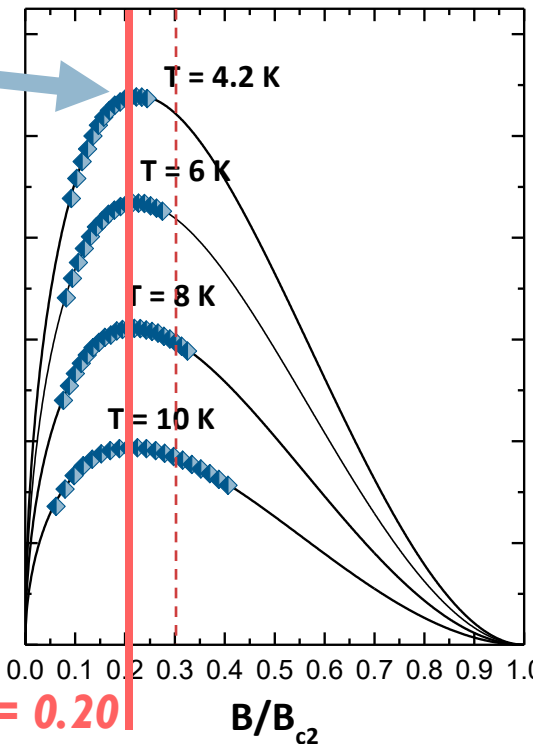


with Hf, with oxygen
source 650°C/200h
grain size = 48 nm



Shift produced by APCs

with Hf, with oxygen
source 700°C/100h
grain size = 58 nm



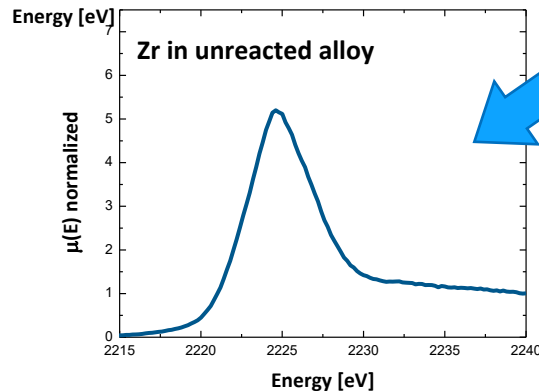
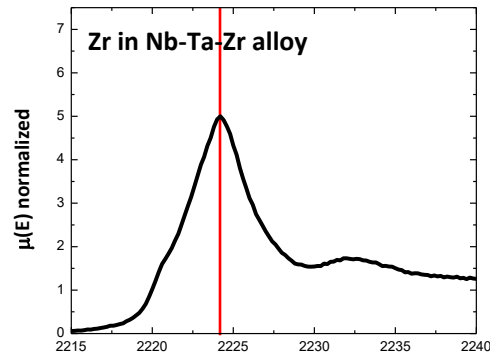
APC shift vanished

APC nanoparticles forms along with Nb_3Sn

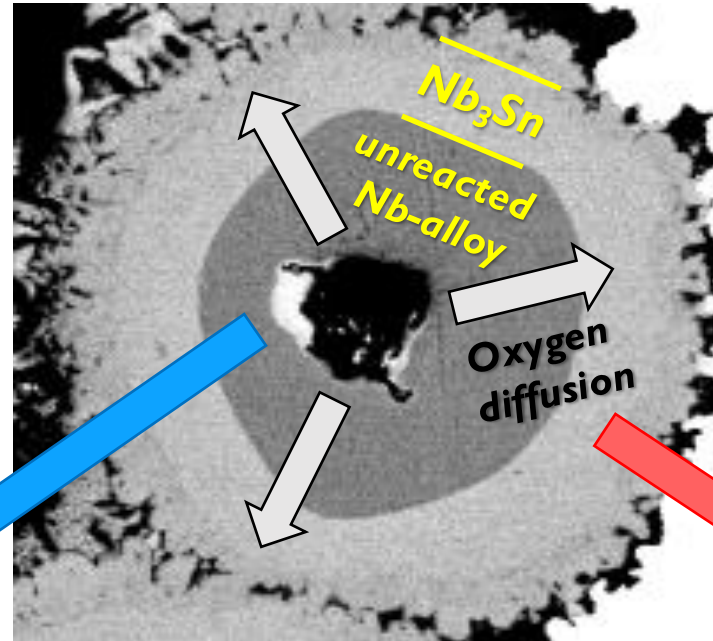
Spatial distribution of the nanoparticles by X-ray Absorption Spectroscopy

REFERENCE #1

XAS spectrum of Zr in Nb-Ta-Zr alloy



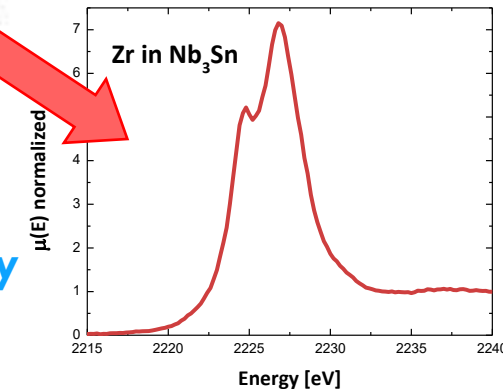
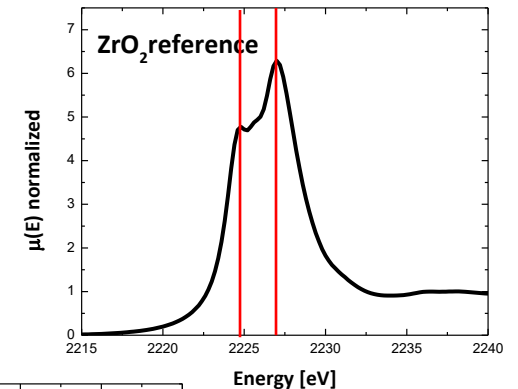
Reacted Monofilamentary Wire



Zr spectrum in unreacted alloy very similar to reference #1 despite the oxygen diffusion during the heat treatment

REFERENCE #2

XAS spectrum of Zr in ZrO_2

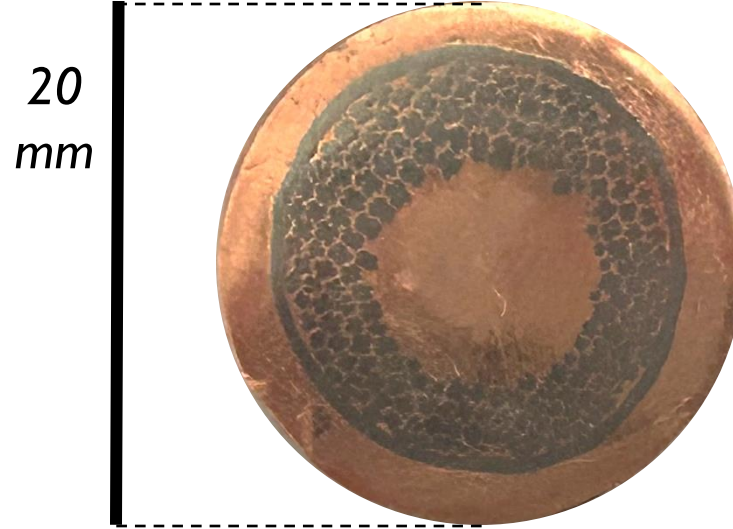


ZrO_2 -like spectrum found only in Nb_3Sn !



G. Bovone et al. *IEEE Trans. Appl. Supercond.* **34** (2024) 6000205
DOI: [10.1109/TASC.2024.3354232](https://doi.org/10.1109/TASC.2024.3354232)

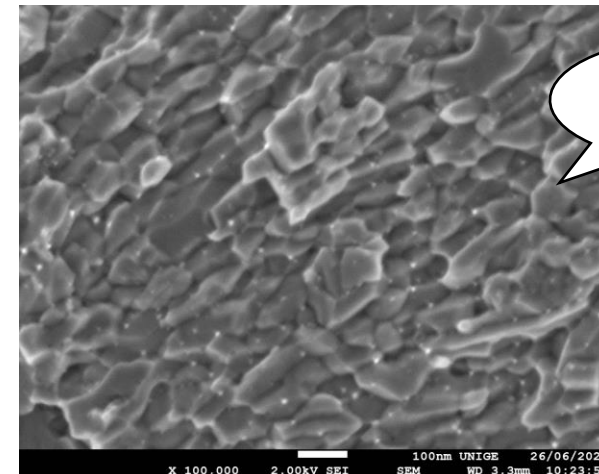
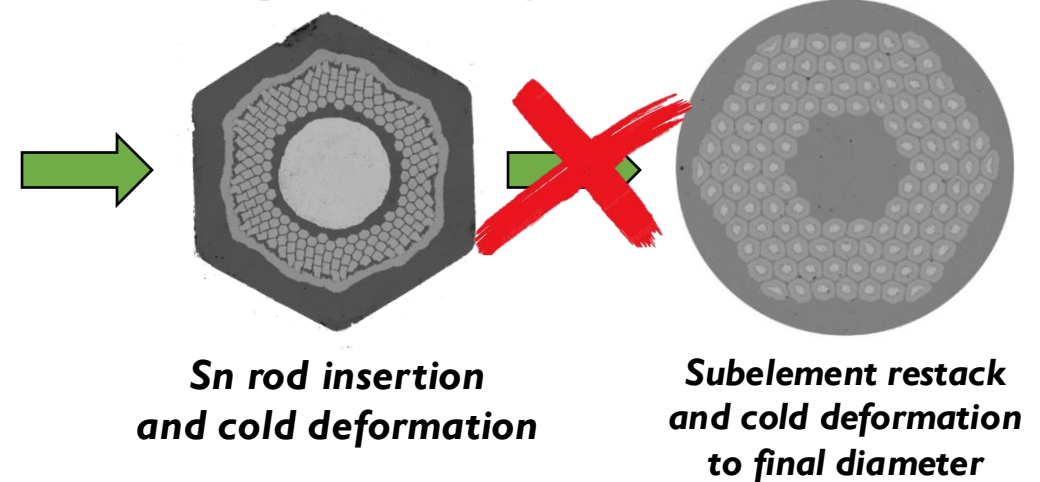
Internal oxidation in extruded subelement



Subelement extruded at 600 °C. Each filament contains OS at the periphery of Nb

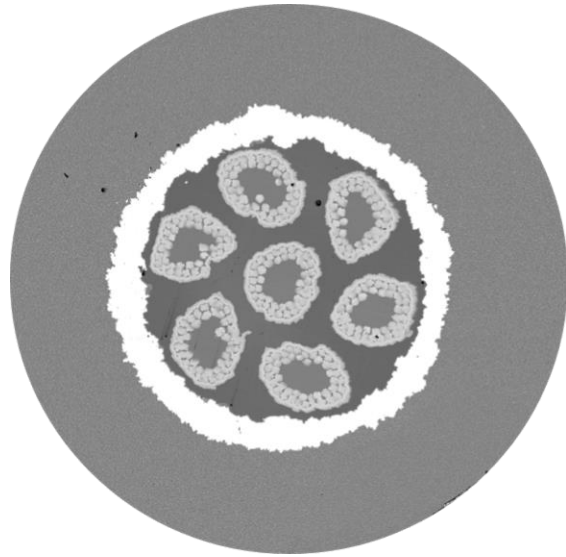
The oxygen source promoted grain refinement of Nb₃Sn

3. Wire processing



< 70 nm

Internal oxidation in a simplified RRP

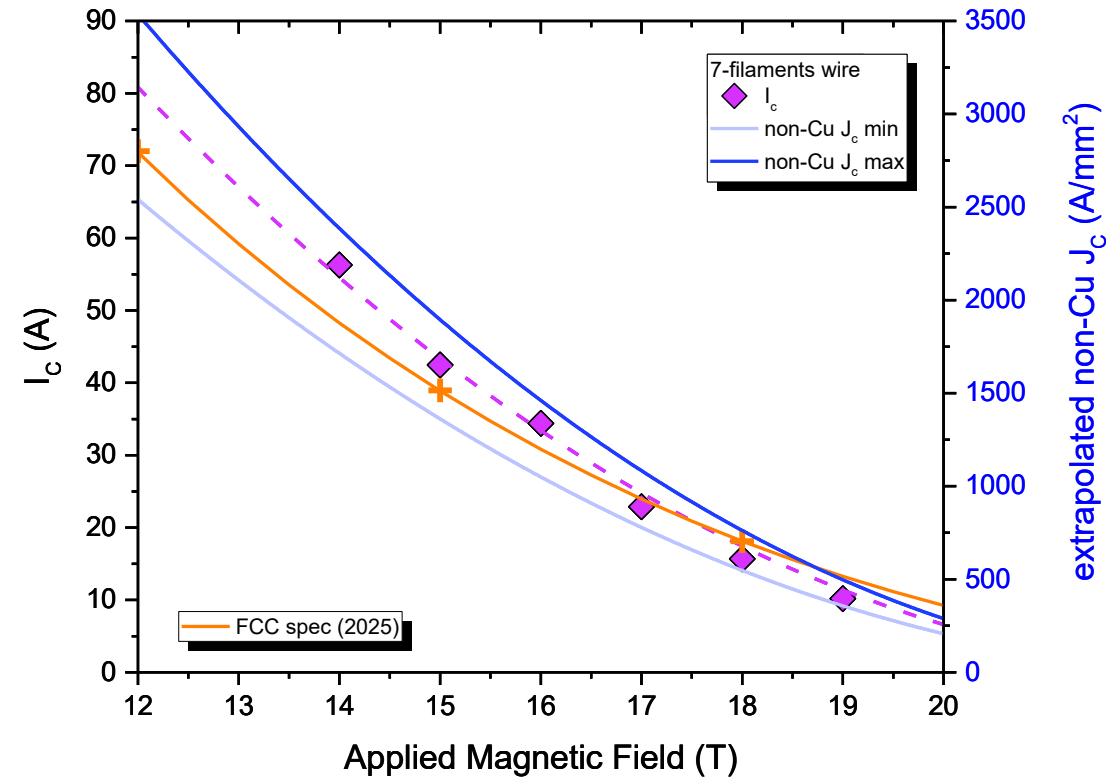


Simplified RRP wire (7/7) made from cold deformed subelements (filaments and subelements are cold deformed)

Wire Properties	Value	Ideal
Reaction %	53.8 %	100 %
Nb/non Cu Area %	50.0 %	50 – 60 %
Nb/Sn at	3.1	3.1 – 3.6
Sn/Sn+Cu wt %	45.1 %	50 – 60 %

Excess of Cu and low Sn content causes the thin reaction layer.

Wide spread results on J_c due to very variable cross-section, low reaction layer and broken subelements



Internal oxidation successfully implemented in a (simplified) Nb_3Sn RRP multifilamentary wire

To conclude

- Despite its “age” **Nb_3Sn is still an important material**
- **FCC-hh** reignite the **fundamental research on Nb_3Sn**
- The **internal oxidation** is the best way to meet **FCC-hh specification** for the wire
- **Internal oxidation** promote **J_c enhancement** due to **grain refinement**,
enhancement of B_{c2} and modified pinning mechanism (APC pinning)
- For applications, **J_c is not all**, as the wire need to be “**robust**”

*Thank you for
your attention*

